Documents

## ADS1284 High-Resolution, Analog-to-Digital Converter

## 1 Features

- Selectable Operating Modes
- Low-Power Mode:
- 12 mW (PGA = 1, 2, 4 and 8)
- 127 dB SNR ( $250 \mathrm{SPS}, \mathrm{PGA}=1$ )
- High-Resolution Mode:
- 18 mW (PGA = 1, 2, 4 and 8)
- 130 dB SNR ( $250 \mathrm{SPS}, \mathrm{PGA}=1$ )
- THD: -122 dB
- CMRR: 110 dB
- Two-Channel Multiplexer
- Inherently-Stable Modulator
- Fast Responding Overrange Detector
- Flexible Digital Filter:
- Sinc + FIR + IIR (Selectable)
- Linear or Minimum Phase Option
- Programmable High-Pass Filter
- Offset and Gain Calibration
- SYNC Input
- Analog Supply: 5 V or $\pm 2.5 \mathrm{~V}$
- Digital Supply: 1.8 V to 3.3 V


## 2 Applications

- Energy Exploration
- Seismic Monitoring
- High-Accuracy Instrumentation


## 3 Description

The ADS1284 is a high-performance, single-chip, analog-to-digital converter (ADC). This device includes a low-noise programmable gain amplifier (PGA), delta-sigma ( $\Delta \Sigma$ ) modulator, and digital filter. The ADC supports two modes of operation with trade-offs between power and resolution.
The two-channel multiplexer has the inputs for signal measurement and an ADC signal test. A mode is available to short circuit the inputs and test for internal noise. The PGA has the high input impedance and low noise, which provides for the direct connection of geophone and hydrophone sensors.
The fourth-order, inherently stable modulator provides outstanding noise and linearity performance. The modulator output is filtered and decimated by the onchip digital filter to yield the ADC conversion result.
The digital filter provides data rates from 250 to 4000 SPS. The high-pass filter (HPF) has a programmable corner frequency. On-chip gain and offset scale registers support system calibration.
The synchronization input controls the timing of the ADC conversion. The power-down input puts the ADC into power-down mode.
The ADS1284 is available in a compact 24 -lead, 5 $\mathrm{mm} \times 4-\mathrm{mm}$ VQFN package, and is fully specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, with a maximum operating temperature range of $-50^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

## Device Information

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
| :--- | :--- | :---: |
| ADS1284 | VQFN $(24)$ | $5.00 \mathrm{~mm} \times 4.00 \mathrm{~mm}$ |

(1) For all available packages, see the package option addendum at the end of the data sheet.

## Simplified Schematic



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## 4 Revision History

Changes from Original (September 2018) to Revision A Page

- Changed document to release full version to web ..... 1


## 5 Pin Configuration and Functions



Pin Functions

| PIN |  | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| NAME | NO. |  |  |
| AINN1 | 13 | Analog input | Negative analog input 1 |
| AINN2 | 11 | Analog input | Negative analog input 2 |
| AINP1 | 12 | Analog input | Positive analog input 1 |
| AINP2 | 10 | Analog input | Positive analog input 2 |
| AVDD | 14 | Analog supply | Positive analog power supply |
| AVSS | 15 | Analog supply | Negative analog power supply |
| BYPAS | 22 | Analog | 1.8-V sub-regulator output: connect 1- $\mu \mathrm{F}$ capacitor to DGND |
| CAPN | 8 | Analog | PGA output: connect 10-nF capacitor from CAPP to CAPN |
| CAPP | 9 | Analog | PGA output: connect 10-nF capacitor from CAPP to CAPN |
| CLK | 23 | Digital input | Master clock input (4.096 MHz) |
| $\overline{\mathrm{CS}}$ | 4 | Digital input | Serial interface chip select, active low |
| DGND | 7 | Ground | Digital ground (tie to digital ground plane) |
| DGND | 21 | Ground | Digital ground (tie to digital ground plane) |
| DIN | 3 | Digital input | Serial interface data input |
| DOUT | 2 | Digital output | Serial Interface data output |
| $\overline{\text { DRDY }}$ | 1 | Digital output | Data ready output: active low |
| DVDD | 20 | Digital supply | Digital power supply. If DVDD <2.25 V, connect DVDD and BYPAS pins together. |
| MFLAG | 6 | Digital output | Modulator overrange flag: $0=$ normal, $1=$ modulator overrange |
| $\overline{\text { PWDN }}$ | 18 | Digital input | Power-down input, active low |
| $\overline{\text { RESET }}$ | 19 | Digital input | Reset input, active low |
| SCLK | 24 | Digital input | Serial interface shift clock input |
| SYNC | 5 | Digital input | Synchronize input, rising edge active |
| VREFN | 16 | Analog input | Negative reference input |
| VREFP | 17 | Analog input | Positive reference input |
| Thermal pad |  |  | Do not electrically connect the thermal pad. The thermal pad must be soldered to PCB. Thermal pad vias are optional and can be removed. |

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## 6 Specifications

### 6.1 Absolute Maximum Ratings ${ }^{(1)}$

Over operating free-air temperature range (unless otherwise noted).

|  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: |
| AVDD to AVSS | -0.3 | 5.5 | V |
| AVSS to DGND | -2.8 | 0.3 | V |
| DVDD to DGND | -0.3 | 3.9 | V |
| Analog input voltage | AVSS - 0.3 | AVDD + 0.3 | V |
| Digital input voltage to DGND | -0.3 | DVDD + 0.3 | V |
| Input current, continuous | -10 | 10 | mA |
| Operating temperature | -50 | 125 | ${ }^{\circ} \mathrm{C}$ |
| Junction temperature |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature, $\mathrm{T}_{\text {stg }}$ | -60 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

### 6.2 ESD Ratings

|  |  |  | VALUE | UNIT |
| :---: | :---: | :---: | :---: | :---: |
|  | E | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ${ }^{(1)}$ | $\pm 2000$ | V |
| $V_{\text {(ESD) }}$ | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 ${ }^{(2)}$ | $\pm 500$ | V |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY |  |  |  |  |  |
| AVSS | Negative analog supply (relative to DGND) | -2.6 |  | 0 | V |
| AVDD | Positive analog supply (relative to AVSS) | AVSS + 4.75 |  | AVSS + 5.25 | V |
| DVDD | Digital supply (relative to DGND) | 1.65 |  | 3.6 | V |
| ANALOG INPUTS |  |  |  |  |  |
| FSR | Full-scale input voltage range ( $\mathrm{V}_{\text {IN }}=$ AINP - AINN $)$ | $\pm \mathrm{V}_{\text {REF }} /(2 \times \mathrm{PGA})$ |  |  | V |
|  | Calibration margin ${ }^{(1)}$ |  |  | 106 | \%FSR |
| AINP or AINN | Absolute input voltage range | AVSS + 0.7 |  | AVDD - 1.25 | V |
| VOLTAGE REFERENCE INPUTS |  |  |  |  |  |
|  | Reference input voltage ( $\mathrm{V}_{\text {REF }}=$ VREFP -VREFN ) | 1 | 5 | AVDD - AVSS + 0.2 | V |
| VREFN | Negative reference input | AVSS - 0.1 |  | VREFP - 1 | V |
| VREFP | Positive reference input | VREFN + 1 |  | AVDD + 0.1 | V |
| DIGITAL INPUTS |  |  |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage | $0.8 \times$ DVDD |  | DVDD | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage | DGND |  | $0.2 \times$ DVDD | V |
| $\mathrm{f}_{\text {CLK }}$ | Clock input | 1 |  | 4.096 | MHz |
| $\mathrm{f}_{\text {SCLK }}$ | Serial clock rate |  |  | $\mathrm{f}_{\text {CLK }} / 2$ | MHz |
| TEMPERATURE |  |  |  |  |  |
|  | Specified temperature | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

(1) Calibration margin is the maximum allowable input voltage after user calibration of offset and gain errors.

### 6.4 Thermal Information

| THERMAL METRIC ${ }^{(1)}$ |  | $\begin{gathered} \text { ADS1284 } \\ \hline \text { RHF (VQFN) } \\ \hline 24 \text { PINS } \end{gathered}$ | UNIT |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
|  |  |  |  |
| $\mathrm{R}_{\text {өJA }}$ | Junction-to-ambient thermal resistance | 30.2 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JCC} \text { (top) }}$ | Junction-to-case (top) thermal resistance | 27.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {өJB }}$ | Junction-to-board thermal resistance | 8.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| \%JT | Junction-to-top characterization parameter | 0.3 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi_{\text {JB }}$ | Junction-to-board characterization parameter | 8.6 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \text { JC(bot) }}$ | Junction-to-case (bottom) thermal resistance | 1.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

### 6.5 Electrical Characteristics

maximum and minimum specifications over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; typical specifications at $25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}$, $\mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution and Low-Power modes, Offset enabled ( 75 mV ), Chop enable, and $\mathrm{f}_{\text {DATA }}=1000$ SPS (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG INPUTS |  |  |  |  |  |
|  | PGA input voltage noise density | Low-power mode | 7.5 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
|  |  | High-resolution mode | 5 |  |  |
|  | Differential input impedance ${ }^{(1)}$ | CHOP enabled | 1 |  | G $\Omega$ |
|  |  | CHOP disabled | 100 |  |  |
|  | Common-mode input impedance |  | 1 |  | $\mathrm{G} \Omega$ |
| $\mathrm{I}_{\mathrm{B}}$ | Input bias current |  | 1 |  | nA |
|  | Crosstalk | $\mathrm{f}=31.25 \mathrm{~Hz}$ | -135 |  | dB |
|  | Mux switch on-resistance | Each switch | 30 |  | $\Omega$ |
| PGA OUTPUT (CAPP, CAPN) |  |  |  |  |  |
|  | Absolute output range |  | AVSS + 0.4 | AVDD - 0.4 | V |
|  | PGA output impedance | Differential | 600 |  | $\Omega$ |
|  | Output impedance tolerance |  | $\pm 10 \%$ |  |  |
|  | External bypass capacitance |  | 10 | 100 | nF |
|  | Modulator input impedance | Low-power mode | 110 |  | k $\Omega$ |
|  |  | High-resolution mode | 55 |  |  |
| AC PERFORMANCE |  |  |  |  |  |
| SNR | Signal-to-noise ratio ${ }^{(2)}$ | Low-power mode | 117 |  | dB |
|  |  | High-resolution mode | 120 124 |  |  |
| THD | Total harmonic distortion ${ }^{(3)}$ | Low-power mode |  |  |  |
|  |  | PGA $=1,2,4,8,16$ | -122 | -114 | dB |
|  |  | PGA $=32$ | -117 | -108 |  |
|  |  | PGA $=64$ | -114 |  |  |
|  |  | High-resolution mode |  |  |  |
|  |  | PGA $=1,2,4,8,16$ | -122 | -114 | dB |
|  |  | PGA $=32$ | -117 | -110 |  |
|  |  | PGA $=64$ | -114 |  |  |
| SFDR | Spurious-free dynamic range |  | 123 |  | dB |

(1) PGA chop mode is controlled by register setting.
(2) Inputs shorted; see Table 1 through Table 4 for more details.
(3) Input signal $=31.25 \mathrm{~Hz},-0.5 \mathrm{dBFS}$.

## Electrical Characteristics (continued)

maximum and minimum specifications over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; typical specifications at $25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}$, $\mathrm{AVSS}=-2.5 \mathrm{~V}$, $\mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}$, DVDD $=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution and Low-Power modes, Offset enabled ( 75 mV ), Chop enable, and $\mathrm{f}_{\text {DATA }}=1000$ SPS (unless otherwise noted)

(4) Offset specification is input referred. The offset scales by the reference voltage ( $\mathrm{V}_{\text {REF }}$ ).
(5) Calibration accuracy is on the level of noise reduced by four (calibration averages 16 readings).
(6) The PGA output impedance and the modulator input impedance results in systematic gain error.
(7) Gain match relative to gain $=1$.
(8) $\mathrm{f}_{\mathrm{CM}}$ is the input common-mode frequency. $\mathrm{f}_{\mathrm{PS}}$ is the power-supply frequency.
(9) Input frequencies in the range of $N \cdot \mathrm{f}_{\mathrm{CLK}} / 1024 \pm \mathrm{f}_{\mathrm{DATA}} / 2$ (where $N=1,2,3 \ldots$ ) can intermodulate with the modulator chopper clock (and $N$ multiples). At these frequencies, intermodulation $=-120 \mathrm{~dB}$, typ.
(10) At dc; see Figure 50.

## Electrical Characteristics (continued)

maximum and minimum specifications over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; typical specifications at $25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}$, $\mathrm{AVSS}=-2.5 \mathrm{~V}$, $\mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}$, DVDD $=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution and Low-Power modes, Offset enabled ( 75 mV ), Chop enable, and $\mathrm{f}_{\text {DATA }}=1000$ SPS (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUTS/OUTPUTS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{l}_{\mathrm{OH}}=1 \mathrm{~mA}$ | $0.8 \times$ DVDD |  |  | V |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | $\mathrm{l}_{\mathrm{OL}}=1 \mathrm{~mA}$ |  |  | $0.2 \times$ DVDD | V |
| $\mathrm{l}_{\mathrm{kg}}$ | Input leakage | $0<\mathrm{V}_{\text {DIGITAL }}$ IN $<$ DVDD |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| POWER SUPPLY |  |  |  |  |  |  |
| IAVDD lavss | Analog supply current | Low-power mode |  |  |  |  |
|  |  | PGA $=1,2,4,8$ |  | 2 | 3.4 | mA |
|  |  | PGA $=16,32,64$ |  | 2.5 | 3.8 |  |
|  |  | High-resolution mode |  |  |  |  |
|  |  | $\mathrm{PGA}=1,2,4,8$ |  | 3.2 | 5.5 | mA |
|  |  | PGA $=16,32,64$ |  | 4 | 6 |  |
|  |  | Standby mode |  | 1 | 15 | $\mu \mathrm{A}$ |
|  |  | Power-down mode |  | 1 | 15 |  |
| $\mathrm{I}_{\text {DVDD }}$ | Digital supply current | Low-power mode |  | 0.5 | 0.7 | mA |
|  |  | High-resolution mode |  | 0.6 | 0.8 |  |
|  |  | Standby mode |  | 25 | 50 | $\mu \mathrm{A}$ |
|  |  | Power-down mode ${ }^{(11)}$ |  | 1 | 15 |  |
| $\mathrm{P}_{\mathrm{D}}$ | Power dissipation | Low-power mode |  |  |  |  |
|  |  | PGA $=1,2,4,8$ |  | 12 | 20 | mW |
|  |  | PGA $=16,32,64$ |  | 14 | 22 |  |
|  |  | High-resolution mode |  |  |  |  |
|  |  | PGA $=1,2,4,8$ |  | 18 | 30 | mW |
|  |  | PGA $=16,32,64$ |  | 22 | 33 |  |
|  |  | Standby mode |  | 90 | 250 | $\mu \mathrm{W}$ |
|  |  | Power-down mode |  | 10 | 125 |  |

(11) CLK input stopped.

### 6.6 Timing Requirements

at $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and DVDD $=1.65 \mathrm{~V}$ to 3.6 V (unless otherwise noted)

|  |  | MIN | MAX |
| :--- | :--- | ---: | :---: |
| $t_{\text {CSSC }}$ | $\overline{C S}$ low to SCLK high: setup time | 40 |  |
| $t_{\text {SCLK }}$ | SCLK period | 2 | ns |
| $\mathrm{t}_{\text {SPWH, }}$ | SCLK pulse duration, high and low ${ }^{(1)}$ | 0.8 | 16 |
| $\mathrm{t}_{\text {DIST }}$ | DIN valid to SCLK high: setup time | 50 | $1 / \mathrm{f}_{\text {CLK }}$ |
| $\mathrm{t}_{\text {DIHD }}$ | Valid DIN to SCLK high: hold time | 50 | $1 / \mathrm{f}_{\text {CLK }}$ |
| $\mathrm{t}_{\text {CSH }}$ | $\overline{\mathrm{CS}}$ high pulse | 100 | ns |
| $\mathrm{t}_{\text {SCCS }}$ | SCLK high to $\overline{\text { CS }}$ high | 24 | ns |

(1) Holding SCLK low for $64 \overline{\mathrm{DRDY}}$ falling edges resets the serial interface.

### 6.7 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX |
| :--- | :--- | :--- | ---: | :---: | :---: |
| $t_{\text {CSDOD }}$ | CS low to DOUT driven: propagation <br> delay |  |  | 60 | ns |
| $\mathrm{t}_{\text {DOPD }}$ | SCLK low to valid new DOUT: <br> propagation delay | Load on DOUT $=20 \mathrm{pF} \\| 100 \mathrm{k} \Omega$ |  | 100 | ns |
| $\mathrm{t}_{\text {DOHD }}$ | SCLK low to DOUT invalid: hold <br> time |  | 0 | ns |  |
| $\mathrm{t}_{\text {CSDOZ }}$ | $\overline{\mathrm{CS}}$ high to DOUT tristate |  |  | 40 | ns |



Figure 1. Serial Interface Timing Diagram

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### 6.8 Typical Characteristics

$\mathrm{At}+25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}$, $\mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution Mode, OFFSET enabled, CHOP enabled, and $f_{\text {DATA }}=1000$ SPS (unless otherwise noted).


Figure 2. Output Spectrum


Figure 4. Output Spectrum


Figure 6. Output Spectrum


Figure 3. Output Spectrum (Low-Power mode)


Figure 5. Output Spectrum (Low-Power Mode)


Figure 7. Output Spectrum (Low-Power Mode)

## Typical Characteristics (continued)

$\mathrm{At}+25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution Mode, OFFSET enabled, CHOP enabled, and $\mathrm{f}_{\text {DATA }}=1000$ SPS (unless otherwise noted).


Figure 8. Output Spectrum


Figure 10. Output Spectrum


Figure 12. Output Spectrum


Figure 9. Output Spectrum (Low-Power Mode)


Figure 11. Output Spectrum (Low-Power Mode)


Figure 13. Output Spectrum (Low-Power Mode)

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## Typical Characteristics (continued)

$\mathrm{At}+25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution Mode, OFFSET enabled, CHOP enabled, and $f_{\text {DATA }}=1000$ SPS (unless otherwise noted).


Figure 14. Output Spectrum


Figure 16. THD vs Temperature


Figure 18. THD vs Signal Frequency


Figure 15. Output Spectrum


Figure 17. THD vs Temperature (Low-Power Mode)


Figure 19. CMR vs Common-Mode Frequency

## Typical Characteristics (continued)

$\mathrm{At}+25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution Mode, OFFSET enabled, CHOP enabled, and $\mathrm{f}_{\text {DATA }}=1000$ SPS (unless otherwise noted).


Figure 20. PSR vs Power-Supply Frequency


Figure 22. Offset-Voltage Drift Histogram


Figure 24. Gain-Error Drift Histogram


Figure 21. Offset-Voltage Histogram


Figure 23. Gain-Error Histogram


Figure 25. Gain-Match Histogram

## Typical Characteristics (continued)

$\mathrm{At}+25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution Mode, OFFSET enabled, CHOP enabled, and $\mathrm{f}_{\text {DATA }}=1000$ SPS (unless otherwise noted).


Figure 26. SNR vs Temperature


Figure 28. Crosstalk Output Spectrum


Figure 30. Input Bias Current vs Input Voltage


Figure 27. SNR vs Temperature (Low-Power Mode)


Figure 29. Power vs Temperature


Figure 31. Input Bias Current vs Input Voltage

## Typical Characteristics (continued)

$\mathrm{At}+25^{\circ} \mathrm{C}, \mathrm{AVDD}=2.5 \mathrm{~V}, \mathrm{AVSS}=-2.5 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}, \mathrm{VREFP}=2.5 \mathrm{~V}, \mathrm{VREFN}=-2.5 \mathrm{~V}, \mathrm{DVDD}=3.3 \mathrm{~V}, \mathrm{PGA}=1$, High-Resolution Mode, OFFSET enabled, CHOP enabled, and $\mathrm{f}_{\mathrm{DATA}}=1000$ SPS (unless otherwise noted).


Figure 32. Reference Input Impedance vs Temperature

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## 7 Parameter Measurement Information

### 7.1 Noise Performance

The ADS1284 offers outstanding signal-to-noise ratio (SNR). SNR depends on data rate, gain and mode of operation (high resolution or low power). As the bandwidth is reduced by decreasing the data rate, SNR improves correspondingly. Similarly, as gain is increased, the input-referred noise decreases. The low power mode decreases the oversampling ratio of the modulator and reduces the bias current of the PGA. As a consequence, low-power mode reduces the operating power but also results in increased conversion noise. The ADC incorporates a chop mode to remove $1 / \mathrm{f}$ noise from the PGA. Chop mode results in increased input current and as a result, chop mode may not be compatible with certain types of hydrophone sensors.
Input-referred noise is related to SNR by Equation 1:

where

- $\mathrm{FSR}_{\text {RMS }}=$ Full-scale range RMS $=\mathrm{V}_{\text {REF }} /(2 \times \sqrt{2} \times \mathrm{PGA})$
- $\mathrm{N}_{\text {RMS }}=$ Noise (RMS, input-referred)

Table 1 summarizes SNR and input-referred noise performance in low-power mode (chop enabled). Table 2 summarizes SNR and input-referred noise performance in low-power mode (chop disabled).

Table 1. Low-Power Mode SNR ( dB ) and Input Referred Noise ( $\mu \mathrm{V}_{\mathrm{RmS}}$ ), Chop Enabled

| DATA RATE (SPS) | PGA (SNR, dB) ${ }^{(1)}$ |  |  |  |  |  |  | PGA (Input-Referred Noise, $\mu \mathrm{V}$ RMS) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 | 2 | 4 | 8 | 16 | 32 | 64 | 1 | 2 | 4 | 8 | 16 | 32 | 64 |
| 250 | 127 | 127 | 126 | 124 | 122 | 116 | 111 | 0.79 | 0.41 | 0.22 | 0.14 | 0.09 | 0.09 | 0.08 |
| 500 | 124 | 124 | 123 | 121 | 119 | 113 | 108 | 1.13 | 0.58 | 0.31 | 0.19 | 0.13 | 0.12 | 0.11 |
| 1000 | 121 | 121 | 120 | 118 | 116 | 110 | 105 | 1.60 | 0.82 | 0.44 | 0.27 | 0.18 | 0.17 | 0.16 |
| 2000 | 118 | 118 | 117 | 115 | 113 | 107 | 102 | 2.27 | 1.16 | 0.63 | 0.39 | 0.26 | 0.24 | 0.22 |
| 4000 | 115 | 114 | 114 | 112 | 110 | 104 | 99 | 3.27 | 1.68 | 0.90 | 0.56 | 0.37 | 0.34 | 0.32 |

(1) Typical values at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. SNR data rounded to the nearest dB . Measurement bandwidth: 0.1 Hz to $0.413 \times$ data rate.

Table 2. Low-Power Mode SNR ( dB ) and Input Referred Noise ( $\mu \mathrm{V}_{\text {RMS }}$ ), Chop Disabled

| DATA RATE (SPS) | PGA (SNR, dB) ${ }^{(1)}$ |  |  |  |  |  |  | PGA (Input-Referred Noise, $\mu \mathrm{V}$ RMS) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 | 2 | 4 | 8 | 16 | 32 | 64 | 1 | 2 | 4 | 8 | 16 | 32 | 64 |
| 250 | 127 | 126 | 122 | 119 | 114 | 107 | 102 | 0.82 | 0.47 | 0.34 | 0.25 | 0.22 | 0.24 | 0.23 |
| 500 | 124 | 123 | 121 | 117 | 113 | 107 | 101 | 1.16 | 0.63 | 0.38 | 0.30 | 0.25 | 0.25 | 0.25 |
| 1000 | 121 | 120 | 119 | 116 | 112 | 106 | 100 | 1.61 | 0.85 | 0.50 | 0.37 | 0.29 | 0.29 | 0.27 |
| 2000 | 118 | 118 | 116 | 114 | 110 | 104 | 99 | 2.28 | 1.19 | 0.68 | 0.47 | 0.35 | 0.35 | 0.32 |
| 4000 | 115 | 114 | 114 | 111 | 108 | 102 | 97 | 3.29 | 1.70 | 0.94 | 0.62 | 0.43 | 0.43 | 0.40 |

(1) Typical values at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. SNR data rounded to the nearest dB . Measurement bandwidth: 0.1 Hz to $0.413 \times$ data rate.

Table 3 summarizes SNR and input-referred noise performance in high-resolution mode (chop enabled). Table 4 summarizes SNR and input-referred noise performance in high-resolution mode (chop disabled).

Table 3. High-Resolution Mode SNR ( dB ) and Input Referred Noise ( $\mu \mathrm{V}_{\text {RMS }}$ ), Chop Enabled

| DATA RATE (SPS) | PGA (SNR, dB) ${ }^{(1)}$ |  |  |  |  |  |  | PGA (Input-Referred Noise, $\mu \mathrm{V}$ RMS) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 | 2 | 4 | 8 | 16 | 32 | 64 | 1 | 2 | 4 | 8 | 16 | 32 | 64 |
| 250 | 130 | 129 | 129 | 127 | 125 | 119 | 114 | 0.59 | 0.30 | 0.16 | 0.10 | 0.07 | 0.06 | 0.06 |
| 500 | 127 | 126 | 126 | 124 | 122 | 116 | 111 | 0.84 | 0.43 | 0.23 | 0.14 | 0.09 | 0.09 | 0.08 |
| 1000 | 124 | 123 | 123 | 121 | 119 | 113 | 108 | 1.19 | 0.60 | 0.32 | 0.20 | 0.13 | 0.12 | 0.11 |
| 2000 | 121 | 120 | 120 | 118 | 116 | 110 | 105 | 1.68 | 0.86 | 0.46 | 0.28 | 0.18 | 0.17 | 0.16 |
| 4000 | 117 | 117 | 117 | 115 | 113 | 107 | 102 | 2.40 | 1.22 | 0.66 | 0.40 | 0.26 | 0.25 | 0.23 |

(1) Typical values at $T_{A}=25^{\circ} \mathrm{C}$. SNR data rounded to the nearest dB . Measurement bandwidth: 0.1 Hz to $0.413 \times$ data rate.

Table 4. High-Resolution Mode SNR ( dB ) and Input Noise ( $\mu \mathrm{V}_{\text {RMS }}$ ), Chop Disabled

| DATA RATE (SPS) | PGA (SNR, dB) ${ }^{(1)}$ |  |  |  |  |  |  | PGA (Input-Referred Noise, $\mu \mathrm{V}$ RMS) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 | 2 | 4 | 8 | 16 | 32 | 64 | 1 | 2 | 4 | 8 | 16 | 32 | 64 |
| 250 | 129 | 128 | 125 | 120 | 116 | 110 | 104 | 0.63 | 0.37 | 0.26 | 0.21 | 0.18 | 0.17 | 0.18 |
| 500 | 126 | 125 | 123 | 119 | 114 | 108 | 103 | 0.87 | 0.47 | 0.31 | 0.25 | 0.21 | 0.21 | 0.20 |
| 1000 | 123 | 123 | 121 | 117 | 114 | 108 | 102 | 1.20 | 0.65 | 0.39 | 0.30 | 0.22 | 0.22 | 0.22 |
| 2000 | 120 | 120 | 119 | 116 | 112 | 107 | 101 | 1.69 | 0.91 | 0.51 | 0.37 | 0.26 | 0.25 | 0.25 |
| 4000 | 117 | 117 | 116 | 114 | 111 | 105 | 99 | 2.41 | 1.24 | 0.70 | 0.46 | 0.33 | 0.31 | 0.30 |

(1) Typical values at $T_{A}=25^{\circ} \mathrm{C}$. SNR data rounded to the nearest dB . Measurement bandwidth: 0.1 Hz to $0.413 \times$ data rate.

## 8 Detailed Description

### 8.1 Overview

The ADS1284 is a high-performance analog-to-digital converter (ADC) designed for energy exploration, seismic monitoring, laboratory instrumentation, and other exacting performance applications. The converter provides 31bit resolution in data rates from 250 SPS to 4000 SPS. See the Functional Block Diagram section for a block diagram of the ADS1284.
The ADS1284 provides two modes of operation, high resolution and low power. The modes offer a tradeoff between power consumption and SNR performance. For most ADC configurations, low-power mode reduces power consumption 6 mW but results in an average 3 dB decrease of SNR. The operating mode is programmed by the MODE register bit (see Figure 71).

The two-channel, differential-input multiplexer allows several measurement configurations:

1. Input 1 (AINP1-AINN1)
2. Input 2 (AINP2 - AINN2)
3. All inputs disconnected. PGA internally shorted to $\mathrm{V}_{\text {Сом }}$ via $400-\Omega$ resistors for ADC noise test.
4. Input 1 and input 2 connected together to the PGA for measurement
5. PGA inputs connected to AINN2 for common-mode test.

The input multiplexer is followed by a continuous-time PGA featuring very low noise. The gain of the PGA is programmed by register settings (gains 1 to 64). A external $10-\mathrm{nF}$ C0G capacitor connected to CAPP and CAPN provides the ADC antialias filter.
The inherently-stable, fourth-order, delta-sigma modulator measures the differential input signal $\left(\mathrm{V}_{\text {IN }}=\right.$ AINP AINN) against the differential reference ( $\mathrm{V}_{\text {REF }}=($ VREFP -VREFN$) / 2$ ) to yield differential input voltage range $=$ $\pm 2.5 \mathrm{~V}$ (PGA = 1). A digital output (MFLAG) indicates the modulator is in overload as a result of an overdrive condition. The modulator digital output data is routed to the digital filter to provide the conversion output data.
The digital filter consists of a variable decimation rate, fifth-order sinc filter, followed by a variable phase, fixeddecimation, finite-impulse response (FIR) low-pass filter with programmable phase. The last filter stage is an adjustable high-pass filter for dc and low frequency signal removal. The output of the digital filter can be taken from the sinc or the FIR filter stages, with the option of the FIR plus high-pass filter stages.
Gain and offset registers scale the output of the digital filter to produce the final output conversion data. The scaling feature can be used for calibration and sensor gain matching.
The SYNC input resets the operation of both the digital filter and the modulator, synchronizing the conversions of multiple ADCs to an external timing event. The SYNC input supports a continuous input mode that accepts an external data frame clock that is locked to the conversion rate. Automatic synchronization occurs when the periods are mismatched.
The $\overline{\mathrm{RESET}}$ input resets the register settings and also restarts the conversion process.
The $\overline{\text { PWDN }}$ input sets the device into power down. Note that register settings are not retained in $\overline{\text { PWDN }}$ mode. Use the STANDBY command for software power down (the quiescent current in standby mode is slightly higher).
Noise-immune Schmitt-trigger and clock-qualified inputs ( $\overline{R E S E T}$ and SYNC) increase reliability in high-noise environments. The SPI ${ }^{\text {TM }}$-compatible serial interface is used to read conversion data, in addition to reading from and writing to the configuration registers.
The device supports either unipolar ( +5 V ) or bipolar ( $\pm 2.5 \mathrm{~V}$ ) supply operation. The digital supply range 1.8 V to 3.3 V .

An internal subregulator powers the digital core from the DVDD supply. BYPAS (pin 28), is the subregulator output and requires a $1-\mu \mathrm{F}$ capacitor for noise reduction. Note that the regulated output voltage on BYPAS is not available to drive external circuitry.

### 8.2 Functional Block Diagram



### 8.3 Feature Description

### 8.3.1 Analog Inputs and Multiplexer

A diagram of the input multiplexer is shown in Figure 33.


Figure 33. Analog Inputs and Multiplexer
ESD diodes protect the multiplexer inputs. If either input is taken below AVSS - 0.3 V , or above AVDD +0.3 V , the ESD protection diodes can turn on. If these conditions are possible, use external clamp diodes, series resistors, or both to limit the input current to safe values (see the Absolute Maximum Ratings table).

## Feature Description (continued)

Overdriving one unused input can affect the conversions of the other input. If an overdriven input interacts with the measured input, clamp the overdriven signal with external Schottky diodes.
The specified input operating range of the PGA is shown in Equation 2:

$$
\begin{equation*}
\text { AVSS }+0.7 \mathrm{~V}<(\text { AINN or AINP })<\text { AVDD }-1.25 \mathrm{~V} \tag{2}
\end{equation*}
$$

For best operation, maintain absolute input levels (input signal level and common-mode level) within these limits.
The multiplexer connects one of the two external differential inputs to the preamplifier inputs, in addition to internal connections for various self-test modes. Table 5 summarizes the multiplexer configurations for Figure 33.

Table 5. Multiplexer Modes

| MUX[2:0] | SWITCHES |  |
| :---: | :---: | :--- |
| 000 | $\mathrm{~S}_{1}, \mathrm{~S}_{5}$ | AINP1 and AINN1 connected to preamplifier |
| 001 | $\mathrm{~S}_{2}, \mathrm{~S}_{6}$ | AINP2 and AINN2 connected to preamplifier |
| 010 | $\mathrm{~S}_{3}, \mathrm{~S}_{4}$ | Preamplifier inputs shorted together through 400- $\Omega$ internal resistors |
| 011 | $\mathrm{~S}_{1}, \mathrm{~S}_{5}, \mathrm{~S}_{2}, \mathrm{~S}_{6}$ | AINP1, AINN1 and AINP2, AINN2 connected together and to the preamplifier |
| 100 | $\mathrm{~S}_{6}, \mathrm{~S}_{7}$ | External short, preamplifier inputs shorted to AINN2 (common-mode test) |

The typical value of multiplexer on-resistance is $30 \Omega$ (each switch). When the multiplexer is used to drive an external load connected to one channel by a signal generator connected to the other channel, on-resistance and on-resistance variation can lead to measurement errors. Figure 34 shows THD versus load resistance and amplitude (PGA gain). In this configuration, THD performance improves when used with high-impedance loads and low amplitude drive signals. The data are measured with the circuit from Figure 35 with the channel connected to each other for measurement (MUX[2:0] = 011).


Figure 34. THD vs External Load and Signal Magnitude (PGA); See Figure 35


Figure 35. Driving an External Load Through the Multiplexer

### 8.3.2 Programmable Gain Amplifier (PGA)

The PGA of the ADS1284 is a low-noise, continuous-time, differential-in and differential-out CMOS amplifier. The gain is set by register bits PGA[2:0], programmable from 1 to 64 . The PGA differentially drives the modulator of the ADC through $300-\Omega$ internal resistors. The effect of the internal resistors and the modulator input impedance results in gain error that changes with operating mode (see Electrical Characteristics). A PGA output filter capacitor (10-nF COG or film dielectric) must be connected to CAPP and CAPN in order to filter modulator sampling glitches. The external capacitor also serves as the antialias filter. The corner frequency of the filter is given in Equation 3:

$$
\begin{equation*}
f_{P}=\frac{1}{6.3 \times 600 \times C} \tag{3}
\end{equation*}
$$

The PGA incorporates chopper stabilization. As shown in Figure 36, amplifiers $A_{1}$ and $A_{2}$ are chopper stabilized to remove the offset, offset drift, and $1 / f$ noise. Chopper stabilization (or chopping) moves the offset and noise to $\mathrm{f}_{\mathrm{CLK}} / 1024\left(4 \mathrm{kHz}, \mathrm{f}_{\mathrm{CLK}}=4.096 \mathrm{MHz}\right)$, which is located safely out of the pass-band frequency range. Chopping can be disabled by setting the CHOP bit $=0$. When chopping is disabled, the PGA input impedance increases (see Differential Input Impedance parameter in the Electrical Characteristics). As shown in Figure 37, chopper stabilization provides flat noise density, leaving the noise spectrum white. However, if chopper stabilization is disabled, the PGA input noise results in a rising 1/f noise profile. The effect of $1 / \mathrm{f}$ noise to the conversion data is most noticeable at high PGA gain setting.

(1) Modulator impedance depends on operating mode. High-resolution mode modulator impedance is $55 \mathrm{k} \Omega$. Low-power mode modulator impedance is $110 \mathrm{k} \Omega$.

Figure 36. PGA Block Diagram


Figure 37. PGA Noise (High-resolution Mode)

As a result of charges stored on stray capacitance of the input chopping switches, low-level transient currents flow through the inputs when chopper stabilization is enabled. The average value of the transient currents results in an effective input impedance. The effective input impedance depends on the PGA gain, as shown in Table 6. Despite the relatively high input impedance, evaluate applications that use high-impedance sensors or highimpedance termination resistors. In some cases, ADC performance may be improved by disabling chopper stabilization. Table 6 shows the PGA differential input impedance with chopper stabilization enabled.

Table 6. Differential Input Impedance (CHOP Enabled)

| PGA | DIFFERENTIAL INPUT IMPEDANCE (G』) |
| :---: | :---: |
| 1 | 7 |
| 2 | 7 |
| 4 | 4 |
| 8 | 3 |
| 16 | 2 |
| 32 | 1 |
| 64 | 0.5 |

The PGA provides programmable gains from 1 to 64 . Table 7 shows the register bit setting for the PGA and resulting full-scale differential range.

Table 7. PGA Gain Settings

| PGA[2:0] | GAIN | DIFFERENTIAL INPUT RANGE <br> $(\mathbf{V})^{(1)}$ |
| :---: | :---: | :---: |
| 000 | 1 | $\pm 2.5$ |
| 001 | 2 | $\pm 1.25$ |
| 010 | 4 | $\pm 0.625$ |
| 011 | 8 | $\pm 0.312$ |
| 100 | 16 | $\pm 0.156$ |
| 101 | 32 | $\pm 0.078$ |
| 110 | 64 | $\pm 0.039$ |

(1) $\mathrm{V}_{\mathrm{REF}}=5 \mathrm{~V}$. The input range scales with $\mathrm{V}_{\text {REF }}$.

The specified range of the PGA output is shown in Equation 4:
AVSS $+0.4 \mathrm{~V}<$ (CAPN or CAPP) $<$ AVDD -0.4 V
For best performance, maintain PGA output levels (signal plus common mode voltage) within these limits.

### 8.3.3 Analog-to-Digital Converter (ADC)

The ADC of the ADS1284 consists of two sections to yield the conversion data result: a low-noise modulator and a programmable digital filter.

### 8.3.3.1 Modulator

The low-noise modulator is an inherently-stable, fourth-order, $\Delta \Sigma, 2+2$ pipelined structure, as Figure 38 shows. The modulator shifts the quantization noise to a higher frequency (out of the passband), where the noise is removed by the digital filter. The modulator data can either be completely filtered by the on-chip digital filter or partially filtered by use of the sinc filter section alone. Partial filtering provided by the sinc filter section is intended for use with an external FIR filter.


Figure 38. ADS1284 Fourth-Order Modulator
Modulator performance is optimized for input signal frequencies over the range dc to 2 kHz . As Figure 39 shows, the effect of PGA and modulator chop result in spectral artifacts occurring at the chop frequency ( 4 kHz ) and harmonics related of the chop frequency. When using the sinc filter output in conjunction with an external postdecimation filter, design the external filter to suppress the modulator chopping artifacts.


Figure 39. Sinc Output FFT (64 kSPS)

### 8.3.3.1.1 Modulator Overrange

The modulator is inherently stable, and therefore, has predictable recovery behavior resulting from an input overdrive condition. The modulator does not exhibit self-reset cycles, which often results in an unstable output data stream. The ADS1284 modulator outputs a data stream with $90 \%$ duty cycle of ones-to-zeroes density with the positive full-scale input signal applied ( $10 \%$ duty cycle with the negative full-scale signal). If the input is overdriven to exceed $10 \%$ or $90 \%$ modulation, but not saturated, the modulator remains stable and continues to output the 1 s density data stream. The digital filter may or may not clip the output codes to + FS or -FS , depending on the duration of the overdrive. When the input returns to the normal range from a long-duration overdrive (worst case), the modulator returns immediately to the normal range, but the group delay of the digital filter delays the return of the conversion data to within the linear range ( 31 readings for linear phase FIR). An additional 31 readings ( 62 total) are required for completely settled data.

If the inputs are overdriven sufficiently to drive the modulator to full duty cycle (that is, all 1 s or all 0 s), the modulator is saturated. The digital output code may clip to +FS or -FS , again depending on the duration of the overdrive. A small-duration overdrive may not always clip the output code. When the input returns to the normal range, the modulator requires up to 12 modulator clock cycles ( $f_{\text {MOD }}$ ) to exit saturation and return to linear operation. The digital filter requires an additional 62 conversions for fully-settled data (linear-phase FIR).

In the extreme case of input overrange (where either overdriven input exceeds the voltage of the analog supply voltage plus the input protection diode drop), the protection diodes begin to conduct, thus clipping the input signal. When the input overdrive is removed, the diodes recover quickly. Make sure to limit the input current to 10 mA (continuous duty) if an overvoltage input signals are possible.

### 8.3.3.1.2 Modulator Input Impedance

The modulator samples the buffered input voltage through an internal capacitor to perform the ADC conversion. The charging of the input sampling capacitor draws a transient current from the PGA output. Use the average value of the current to calculate an effective input impedance, as shown in Equation 5:
$R_{\text {EFF }}=1 /\left(f_{\text {MOD }} \times C_{S}\right)$
where

- $\mathrm{f}_{\text {MOD }}=$ Modulator sample frequency $=$ CLK / 4 (CLK / 8 for low-power mode)
- $\mathrm{C}_{\mathrm{S}}=$ Input sampling capacitor $=17 \mathrm{pF}$ (typ)

The resulting modulator input impedance is $55 \mathrm{k} \Omega$ ( $110 \mathrm{k} \Omega$ low-power mode). The modulator input impedance and the PGA output resistors result in systematic gain errors. The modulator sampling capacitor and PGA output resistors can each vary up to $\pm 20 \%$ over production lots, affecting the nominal gain error.

### 8.3.3.1.3 Modulator Overrange Detection (MFLAG)

The ADS1284 has a fast-responding, overrange detection that indicates when the differential input exceeds $100 \%$ or $-100 \%$ full-scale. The threshold tolerance is $\pm 2.5 \%$. The MFLAG output pin asserts high when in an overrange condition. As Figure 40 and Figure 41 illustrate, the absolute differential input is compared to $100 \%$ of range. The output of the comparator is sampled at the rate of $f_{\text {MOD }} / 2$, yielding the MFLAG output. The minimum detectable MFLAG pulse duration is $f_{\text {MOD }} / 2$.


Figure 40. Modulator Overrange Block Diagram


Figure 41. Modulator Overrange Flag Operation

### 8.3.3.1.4 Offset

The modulator can produce low-level idle tones that appear in the conversion data when there is no signal input or when low-level signal inputs are present to the ADC. The ADC provides an optional dc offset voltage designed to shift the idle tones to the stop band of digital filter response, where the idle tones are reduced. The internal offset is applied at the modulator input; therefore, the offset voltage is independent of PGA gain. Two offset voltage options are provided, 75 mV and 100 mV . The $75-\mathrm{mV}$ offset is more effective to reduce idle tones under various gain, data rate, and chop mode settings.
The offset is enabled by the OFFSET1 and OFFSET0 bits (default is off). The offset voltage reduces the total available input range $4 \%$ ( $3 \%$ for the 75 mV value) before the onset of clipped conversion results. To restore the full range of the ADC, calibrate the offset voltage by the digital offset calibration register (OFC[2:0]). See Offset and Full-Scale Calibration Registers and Calibration Commands (OFSCAL and GANCAL) sections for details.

### 8.3.3.1.5 Voltage Reference Inputs (VREFP, VREFN)

The voltage reference of the ADS1284 is the differential voltage applied between pins VREFP and VREFN:

$$
\begin{equation*}
\mathrm{V}_{\text {REF }}=\mathrm{VREFP}-\mathrm{VREFN} \tag{6}
\end{equation*}
$$

The reference inputs use a structure similar to that of the analog inputs with the circuitry of the reference inputs shown in Figure 42. The average load presented by the switched-capacitor reference input can be modeled with an effective differential impedance of:

$$
\begin{equation*}
R_{\text {EFF }}=t_{\text {SAMPLE }} / C_{\text {IN }}\left(\mathrm{t}_{\text {SAMPLE }}=1 / \mathrm{f}_{\text {MOD }}\right) . \tag{7}
\end{equation*}
$$

Note that the effective impedance of the reference inputs loads the external reference.

$R_{\text {EFF }}$ shown for high-resolution mode operation. $R_{\text {EFF }}$ for low-power mode operation is $170 \mathrm{k} \Omega$
Figure 42. Simplified Reference Input Circuit
Place a $0.1-\mu \mathrm{F}$ ceramic capacitor directly between the ADC VREFP and VREFN pins. Multiple ADC applications can share a single voltage reference, but must have individual capacitors placed at each ADC.
The ADS1284 reference inputs are protected by ESD diodes. In order to prevent these diodes from turning on, the voltage on either input must stay within the range shown in Equation 8:

$$
\begin{equation*}
\text { AVSS }-300 \mathrm{mV}<(\text { VREFP or VREFN })<\text { AVDD }+300 \mathrm{mV} \tag{8}
\end{equation*}
$$

The minimum operational input range for VREFN is AVSS -0.1 V , and the maximum operational range for VREFP is AVDD + 0.1 V.

To achieve the best ADC performance, use a low-noise $5-\mathrm{V}$ voltage reference. A $4.096-\mathrm{V}$ or $4.5-\mathrm{V}$ reference voltage can be used; however, these lower reference voltages reduce the signal input range and corresponding decrease SNR. Noise and drift on the reference degrade overall system performance. To achieve optimum performance, give attention to the circuitry providing the reference voltage including possible use of noise filtering. See the Application Information section for reference recommendations.

### 8.3.3.2 Digital Filter

The digital filter receives the modulator output data stream and decimates and filters the data. By adjusting the amount of filtering, tradeoffs can be made between resolution and data rate: filter more for higher resolution, filter less for higher data rate.
The digital filter is comprised of three filter sections: a variable-decimation, fifth-order sinc filter; a fixeddecimation FIR, low-pass filter (LPF) with selectable phase; and a programmable, first-order, high-pass filter (HPF), as shown in Figure 43.


Figure 43. Digital Filter and Output Code Processing
The output can be taken from one of the three filter sections, as Figure 43 shows. For partial filtering of the conversion data, select the sinc filter mode. The sinc filter mode is intended for use in conjunction with an external FIR filter. For complete on-chip filtering, select the sinc + FIR mode. With sinc + FIR filter mode active, the HPF can be included to remove dc and low frequencies from the data. Table 8 shows the filter mode options.

Table 8. Digital Filter Selection

| FILTR[1:0] BITS | DIGITAL FILTER MODE |
| :---: | :---: |
| 00 | Reserved (not used) |
| 01 | Sinc |
| 10 | Sinc + FIR |
| 11 | Sinc + FIR + HPF |

### 8.3.3.2.1 Sinc Filter Section $(\sin \mathbf{x} / \mathbf{x})$

The sinc filter is a variable decimation rate, fifth-order, low-pass filter. Data are supplied to this section of the filter from the modulator at the rate of $f_{\text {MOD }}=f_{\text {CLK }} / 4$ (high-resolution mode) or $\mathrm{f}_{\text {MOD }}=\mathrm{f}_{\text {CLK }} / 8$ (low-power mode). The sinc filter attenuates high-frequency noise produced by the modulator and also reduces the data rate (decimation ratio) in proportion to the amount of filtering. The decimation ratio of the sinc filter effects the overall data rate of the converter. The sinc and sinc + FIR filter mode data rates are programmed by the DR[2:0] register bits. The sinc filter mode data rates are shown in Table 9.

Table 9. Sinc Filter Mode Data Rates

| DR[2:0] REGISTER | DECIMATION RATIO (N) |  |  |
| :---: | :---: | :---: | :---: |
|  | HIGH-RESOLUTION MODE | LOW-POWER MODE | DATA RATE (SPS) |
|  | 128 | 64 |  |
| 001 | 64 | 32 | 16,000 |
| 010 | 32 | 16 | 32,000 |
| 011 | 16 | 8 | 64,000 |
| 100 | 8 | 4 | 128,000 |

Equation 9 shows the scaled Z-domain transfer function of the sinc filter.
$H(Z)=\left[\frac{1-Z^{-N}}{N\left(1-Z^{-1}\right)}\right]^{5}$
where

$$
\begin{equation*}
\text { - } \mathrm{N}=\text { decimation ratio } \tag{9}
\end{equation*}
$$

Equation 10 shows the frequency domain transfer function of the sinc filter.

$$
|H(f)|=\left|\frac{\sin \left(\frac{\pi N \times f}{f_{M O D}}\right)}{N \sin \left(\frac{\pi \times f}{f_{M O D}}\right)}\right|^{5}
$$

where

- $\mathrm{N}=$ decimation ratio (see Table 9)
- $\mathrm{f}_{\text {MOD }}=\mathrm{f}_{\text {CLK }} / 4$ (high-resolution mode) or $\mathrm{f}_{\text {CLK }} / 8$ (low-power mode)

The sinc filter has notches (or zeros) that occur at the output data rate and multiples thereof. At these frequencies, the filter has zero gain. Figure 44 shows the frequency response of the sinc filter and Figure 45 shows the roll-off of the sinc filter.


### 8.3.3.2.2 FIR Section

The second section of the digital filter is an FIR low-pass filter. Data are supplied to this section from the sinc filter. The FIR stage is segmented into four subsections, as shown in Figure 46.


Figure 46. FIR Filter

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The first two subsections are half-band filters with fixed decimation ratios of two. The third subsection of the FIR filter decimates by four (fixed), and the fourth subsection decimates by two (fixed). The overall decimation ratio of the entire FIR section is 32 . Two coefficient sets are used for the third and fourth subsections, sets for linear phase mode and minimum phase mode (programmable). Table 10 lists the data rate programming and overall decimation ratio of the FIR stage. See Table 11 for the FIR filter coefficients.

Table 10. FIR Filter Data Rates

| DR[2:0] <br> REGISTER | OVERALL DECIMATION RATIO (COMBINED SINC + FIR) |  |  |
| :---: | :---: | :---: | :---: |
|  | HIGH-RESOLUTION MODE | LOW-POWER MODE |  |
| 000 | 4096 | 2048 | 250 |
| 001 | 2048 | 1024 | 500 |
| 010 | 1024 | 512 | 1000 |
| 011 | 512 | 256 | 2000 |
| 100 | 256 | 128 | 4000 |

Table 11. FIR Stage Coefficients

| COEFFICIENT | SECTION 1 | SECTION 2 |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | LINEAR PHASE SCALING = 1 / 512 | LINEAR PHASE SCALING = 1 / 8388608 | SCALING = $1 / 134217728$ |  | SCALING = 1 / 134217728 |  |
|  |  |  | LINEAR <br> PHASE | MINIMUM PHASE | LINEAR <br> PHASE | MINIMUM PHASE |
| $\mathrm{b}_{0}$ | 3 | -10944 | 0 | 819 | -132 | 11767 |
| $\mathrm{b}_{1}$ | 0 | 0 | 0 | 8211 | -432 | 133882 |
| $\mathrm{b}_{2}$ | -25 | 103807 | -73 | 44880 | -75 | 769961 |
| $\mathrm{b}_{3}$ | 0 | 0 | -874 | 174712 | 2481 | 2940447 |
| $\mathrm{b}_{4}$ | 150 | -507903 | -4648 | 536821 | 6692 | 8262605 |
| $\mathrm{b}_{5}$ | 256 | 0 | -16147 | 1372637 | 7419 | 17902757 |
| $\mathrm{b}_{6}$ | 150 | 2512192 | -41280 | 3012996 | -266 | 30428735 |
| $\mathrm{b}_{7}$ | 0 | 4194304 | -80934 | 5788605 | -10663 | 40215494 |
| $\mathrm{b}_{8}$ | -25 | 2512192 | -120064 | 9852286 | -8280 | 39260213 |
| $\mathrm{b}_{9}$ | 0 | 0 | -118690 | 14957445 | 10620 | 23325925 |
| $\mathrm{b}_{10}$ | 3 | -507903 | -18203 | 20301435 | 22008 | -1757787 |
| $\mathrm{b}_{11}$ |  | 0 | 224751 | 24569234 | 348 | -21028126 |
| $\mathrm{b}_{12}$ |  | 103807 | 580196 | 26260385 | -34123 | -21293602 |
| $\mathrm{b}_{13}$ |  | 0 | 893263 | 24247577 | -25549 | -3886901 |
| $\mathrm{b}_{14}$ |  | -10944 | 891396 | 18356231 | 33460 | 14396783 |
| $\mathrm{b}_{15}$ |  |  | 293598 | 9668991 | 61387 | 16314388 |
| $\mathrm{b}_{16}$ |  |  | -987253 | 327749 | -7546 | 1518875 |
| $\mathrm{b}_{17}$ |  |  | -2635779 | -7171917 | -94192 | -12979500 |
| $\mathrm{b}_{18}$ |  |  | -3860322 | -10926627 | -50629 | -11506007 |
| $\mathrm{b}_{19}$ |  |  | -3572512 | -10379094 | 101135 | 2769794 |
| $\mathrm{b}_{20}$ |  |  | -822573 | -6505618 | 134826 | 12195551 |
| $\mathrm{b}_{21}$ |  |  | 4669054 | -1333678 | -56626 | 6103823 |
| $\mathrm{b}_{22}$ |  |  | 12153698 | 2972773 | -220104 | -6709466 |
| $\mathrm{b}_{23}$ |  |  | 19911100 | 5006366 | -56082 | -9882714 |
| $\mathrm{b}_{24}$ |  |  | 25779390 | 4566808 | 263758 | -353347 |
| $\mathrm{b}_{25}$ |  |  | 27966862 | 2505652 | 231231 | 8629331 |
| $\mathrm{b}_{26}$ |  |  | 25779390 | 126331 | -215231 | 5597927 |
| $\mathrm{b}_{27}$ |  |  | 19911100 | -1496514 | -430178 | -4389168 |
| $\mathrm{b}_{28}$ |  |  | 12153698 | -1933830 | 34715 | -7594158 |
| $\mathrm{b}_{29}$ |  |  | 4669054 | -1410695 | 580424 | -428064 |

Table 11. FIR Stage Coefficients (continued)

| COEFFICIENT | SECTION 1 | SECTION 2 |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | LINEAR PHASE SCALING = 1 / 512 | LINEAR PHASE SCALING = 1 / 8388608 | SCALING = 1 / 134217728 |  | SCALING = 1 / 134217728 |  |
|  |  |  | LINEAR PHASE | MINIMUM PHASE | LINEAR PHASE | MINIMUM PHASE |
| $\mathrm{b}_{30}$ |  |  | -822573 | -502731 | 283878 | 6566217 |
| $\mathrm{b}_{31}$ |  |  | -3572512 | 245330 | -588382 | 4024593 |
| $\mathrm{b}_{32}$ |  |  | -3860322 | 565174 | -693209 | -3679749 |
| $\mathrm{b}_{33}$ |  |  | -2635779 | 492084 | 366118 | -5572954 |
| $\mathrm{b}_{34}$ |  |  | -987253 | 231656 | 1084786 | 332589 |
| $\mathrm{b}_{35}$ |  |  | 293598 | -9196 | 132893 | 5136333 |
| $\mathrm{b}_{36}$ |  |  | 891396 | -125456 | -1300087 | 2351253 |
| $\mathrm{b}_{37}$ |  |  | 893263 | -122207 | -878642 | -3357202 |
| $\mathrm{b}_{38}$ |  |  | 580196 | -61813 | 1162189 | -3767666 |
| $\mathrm{b}_{39}$ |  |  | 224751 | -4445 | 1741565 | 1087392 |
| $\mathrm{b}_{40}$ |  |  | -18203 | 22484 | -522533 | 3847821 |
| $\mathrm{b}_{41}$ |  |  | -118690 | 22245 | -2490395 | 919792 |
| $\mathrm{b}_{42}$ |  |  | -120064 | 10775 | -688945 | -2918303 |
| $\mathrm{b}_{43}$ |  |  | -80934 | 940 | 2811738 | -2193542 |
| $\mathrm{b}_{44}$ |  |  | -41280 | -2953 | 2425494 | 1493873 |
| $\mathrm{b}_{45}$ |  |  | -16147 | -2599 | -2338095 | 2595051 |
| $\mathrm{b}_{46}$ |  |  | -4648 | -1052 | -4511116 | -79991 |
| $\mathrm{b}_{47}$ |  |  | -874 | -43 | 641555 | -2260106 |
| $\mathrm{b}_{48}$ |  |  | -73 | 214 | 6661730 | -963855 |
| $\mathrm{b}_{49}$ |  |  | 0 | 132 | 2950811 | 1482337 |
| $\mathrm{b}_{50}$ |  |  | 0 | 33 | -8538057 | 1480417 |
| $\mathrm{b}_{51}$ |  |  | 0 | 0 | -10537298 | -586408 |
| $\mathrm{b}_{52}$ |  |  |  |  | 9818477 | -1497356 |
| $\mathrm{b}_{53}$ |  |  |  |  | 41426374 | -168417 |
| $\mathrm{b}_{54}$ |  |  |  |  | 56835776 | 1166800 |
| $\mathrm{b}_{55}$ |  |  |  |  | 41426374 | 644405 |
| $\mathrm{b}_{56}$ |  |  |  |  | 9818477 | -675082 |
| $\mathrm{b}_{57}$ |  |  |  |  | -10537298 | -806095 |
| $\mathrm{b}_{58}$ |  |  |  |  | -8538057 | 211391 |
| $\mathrm{b}_{59}$ |  |  |  |  | 2950811 | 740896 |
| $\mathrm{b}_{60}$ |  |  |  |  | 6661730 | 141976 |
| $\mathrm{b}_{61}$ |  |  |  |  | 641555 | -527673 |
| $\mathrm{b}_{62}$ |  |  |  |  | -4511116 | -327618 |
| $\mathrm{b}_{63}$ |  |  |  |  | -2338095 | 278227 |
| $\mathrm{b}_{64}$ |  |  |  |  | 2425494 | 363809 |
| $\mathrm{b}_{65}$ |  |  |  |  | 2811738 | -70646 |
| $\mathrm{b}_{66}$ |  |  |  |  | -688945 | -304819 |
| $\mathrm{b}_{67}$ |  |  |  |  | -2490395 | -63159 |
| $\mathrm{b}_{68}$ |  |  |  |  | -522533 | 205798 |
| $\mathrm{b}_{69}$ |  |  |  |  | 1741565 | 124363 |
| $\mathrm{b}_{70}$ |  |  |  |  | 1162189 | -107173 |
| $\mathrm{b}_{71}$ |  |  |  |  | -878642 | -131357 |
| $\mathrm{b}_{72}$ |  |  |  |  | -1300087 | 31104 |
| $\mathrm{b}_{73}$ |  |  |  |  | 132893 | 107182 |
| $\mathrm{b}_{74}$ |  |  |  |  | 1084786 | 15644 |

Table 11. FIR Stage Coefficients (continued)

| COEFFICIENT | SECTION 1 | SECTION 2 |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | LINEAR PHASE SCALING = $1 / 512$ | LINEAR PHASE SCALING = 1 / 8388608 | SCALING = 1 / 134217728 |  | SCALING = 1 / 134217728 |  |
|  |  |  | LINEAR PHASE | MINIMUM PHASE | LINEAR <br> PHASE | MINIMUM PHASE |
| $\mathrm{b}_{75}$ |  |  |  |  | 366118 | -71728 |
| $\mathrm{b}_{76}$ |  |  |  |  | -693209 | -36319 |
| $\mathrm{b}_{77}$ |  |  |  |  | -588382 | 38331 |
| $\mathrm{b}_{78}$ |  |  |  |  | 283878 | 38783 |
| $\mathrm{b}_{79}$ |  |  |  |  | 580424 | -13557 |
| $\mathrm{b}_{80}$ |  |  |  |  | 34715 | -31453 |
| $\mathrm{b}_{81}$ |  |  |  |  | -430178 | -1230 |
| $\mathrm{b}_{82}$ |  |  |  |  | -215231 | 20983 |
| $\mathrm{b}_{83}$ |  |  |  |  | 231231 | 7729 |
| $\mathrm{b}_{84}$ |  |  |  |  | 263758 | -11463 |
| $\mathrm{b}_{85}$ |  |  |  |  | -56082 | -8791 |
| $\mathrm{b}_{86}$ |  |  |  |  | -220104 | 4659 |
| $\mathrm{b}_{87}$ |  |  |  |  | -56626 | 7126 |
| $\mathrm{b}_{88}$ |  |  |  |  | 134826 | -732 |
| $\mathrm{b}_{89}$ |  |  |  |  | 101135 | -4687 |
| $\mathrm{b}_{90}$ |  |  |  |  | -50629 | -976 |
| $\mathrm{b}_{91}$ |  |  |  |  | -94192 | 2551 |
| $\mathrm{b}_{92}$ |  |  |  |  | -7546 | 1339 |
| $\mathrm{b}_{93}$ |  |  |  |  | 61387 | -1103 |
| $\mathrm{b}_{94}$ |  |  |  |  | 33460 | -1085 |
| $\mathrm{b}_{95}$ |  |  |  |  | -25549 | 314 |
| $\mathrm{b}_{96}$ |  |  |  |  | -34123 | 681 |
| $\mathrm{b}_{97}$ |  |  |  |  | 348 | 16 |
| $\mathrm{b}_{98}$ |  |  |  |  | 22008 | -349 |
| $\mathrm{b}_{99}$ |  |  |  |  | 10620 | -96 |
| $\mathrm{b}_{100}$ |  |  |  |  | -8280 | 144 |
| $\mathrm{b}_{101}$ |  |  |  |  | -10663 | 78 |
| $\mathrm{b}_{102}$ |  |  |  |  | -266 | -46 |
| $\mathrm{b}_{103}$ |  |  |  |  | 7419 | -42 |
| $\mathrm{b}_{104}$ |  |  |  |  | 6692 | 9 |
| $\mathrm{b}_{105}$ |  |  |  |  | 2481 | 16 |
| $\mathrm{b}_{106}$ |  |  |  |  | -75 | 0 |
| $\mathrm{b}_{107}$ |  |  |  |  | -432 | -4 |
| $\mathrm{b}_{108}$ |  |  |  |  | -132 | 0 |
| $\mathrm{b}_{109}$ |  |  |  |  | 0 | 0 |

As shown in Figure 47, the frequency response of the FIR filter is minimum ripple, flat to 0.375 of the data rate ( $\pm 0.003 \mathrm{~dB}$ pass-band ripple until $0.375 \cdot \mathrm{f}_{\text {DATA }}$ ) and is fully attenuated at the Nyquist frequency. Figure 48 shows the transition from pass band to stop band.


Although not shown in Figure 48, the pass-band response repeats at multiples of the modulator frequency ( N $f_{\text {MOD }}-f_{0}$ and $N \cdot f_{\text {MOD }}+f_{0}$, where $N=1,2$, and so on, and $f_{0}=$ pass band). These image frequencies, if present in the signal and not filtered before the analog-to-digital conversion process, fold back (or alias) into the pass band and cause errors. A low-pass signal filter reduces the amplitude of the aliasing frequencies. Often, the RC low-pass filter provided by the PGA output resistance and the external capacitor connected to CAPP and CAPN provide sufficient anti-alias attenuation.

### 8.3.3.2.3 Group Delay and Step Response

The FIR block is implemented as a multistage FIR structure with selectable linear or minimum phase response. The pass band, transition band, and stop band responses of the filters are nearly identical but differ in the respective phase responses.

### 8.3.3.2.3.1 Linear Phase Response

Linear phase filters exhibit constant delay time versus input frequency (that is, constant group delay). Linear phase filters have the property that the time delay is constant from any instant of the input signal to the same instant of the output data, and is independent of the signal frequency. This filter behavior results in essentially zero phase error when analyzing multi-tone signals. However, the group delay is longer than the minimum phase filter, as shown in Figure 49.


Figure 49. FIR Step Response

### 8.3.3.2.3.2 Minimum Phase Response

The minimum phase filter provides a short delay from the arrival of an input signal to the output of conversion data, but the phase relationship is not constant versus frequency, as shown in Figure 50. The filter phase is selected by the PHS bit, as Table 12 shows.


Figure 50. FIR Group Delay ( $\mathrm{f}_{\text {DATA }}=500 \mathrm{~Hz}$ )
Table 12. FIR Filter Phase Selection

| PHS BIT | FILTER PHASE |
| :---: | :---: |
| 0 | Linear |
| 1 | Minimum |

### 8.3.3.2.4 HPF Section

The last section of the digital filter is a first-order HPF implemented as an IIR structure. This filter stage blocks dc signals, and rolls-off low frequency components below the cutoff frequency. The transfer function for the filter is shown in Equation 11:

$$
\operatorname{HPF}(Z)=\frac{2-a}{2} \times \frac{1-Z^{-1}}{1-b Z^{-1}}
$$

where

- $b$ is calculated as shown in Equation 12

$$
\begin{equation*}
\mathrm{b}=\frac{1+(1-\mathrm{a})^{2}}{2} \tag{11}
\end{equation*}
$$

The high-pass corner frequency is programmed by registers HPF[1:0], in hexadecimal. Equation 13 is used to set the high-pass corner frequency. Table 13 lists example values for the high-pass filter.
$\operatorname{HPF}[1: 0]=65,536\left[1-\sqrt{1-2 \frac{\cos \omega_{N}+\sin \omega_{N}-1}{\cos \omega_{N}}}\right]$
where

- HPF[1:0] = High-pass filter register value (converted to hexadecimal)
- $\omega_{N}=2 \pi f_{H P} / f_{\text {DATA }}$ (normalized frequency, radians)
- $f_{H P}=$ High-pass corner frequency $(\mathrm{Hz})$
- $\mathrm{f}_{\text {DATA }}=$ Data rate (Hz)

Table 13. High-Pass Filter Value Examples

| $\mathbf{f}_{\mathbf{H P}} \mathbf{( H z )}$ | DATA RATE (SPS) | HPF[1:0] |
| :---: | :---: | :---: |
| 0.5 | 250 | 0337 h |
| 1.0 | 500 | 0337 h |
| 1.0 | 1000 | 019 Ah |

The HPF causes a small gain error, in which case the magnitude of the error depends on the ratio of $f_{\text {HP }} / f_{\text {DATA }}$. For many common values of ( $\mathrm{f}_{\text {HP }} / \mathrm{f}_{\text {DATA }}$ ), the gain error is negligible. Figure 51 shows the gain error of the HPF.


Figure 51. HPF Gain Error
The gain error factor is calculated in Equation 14:

$$
\begin{equation*}
\text { HPF Gain }=\frac{1+\sqrt{1-2\left(\frac{\cos \omega_{N}+\sin \omega_{N}-1}{\cos \omega_{N}}\right)}}{2-\left(\frac{\cos \omega_{N}+\sin \omega_{N}-1}{\cos \omega_{N}}\right]} \tag{14}
\end{equation*}
$$

Figure 52 shows the first-order amplitude and phase response of the HPF. In the case of applying step inputs (changing gains or inputs) or synchronizing, make sure to take the settling time of the filter into account.


Figure 52. HPF Amplitude and Phase Response

### 8.4 Device Functional Modes

### 8.4.1 Synchronization (SYNC PIN and SYNC Command)

The ADS1284 can be synchronized to an external event, as well as synchronizing multiple ADS1284 devices together if the synchronization pulse is applied simultaneously.
The ADS1284 has two methods of synchronization: the SYNC input pin and the SYNC command. In addition, there are two synchronization modes: pulse-sync and continuous-sync. In pulse-sync mode, the ADS1284 synchronizes unconditionally at each synchronization event. In continuous-sync mode, the first synchronization is unconditional, thereafter the ADC re-synchronizes only when the next SYNC pin edge does not occur at an integer multiple of the data rate. Typically, a synchronization clock is applied to the SYNC pin with a period equal to an integer multiple of the data rate. When the periods of the SYNC input and the DRDY output do not match due to system glitch or clock noise event, the ADC re-synchronizes.

### 8.4.1.1 Pulse-Sync Mode

In pulse-sync mode, the ADS1284 unconditionally synchronizes by stopping and restarting the conversion process. Synchronization is possible by pin or command in this mode. At synchronization, the device resets the internal filter memory, DRDY goes high, and after the digital filter has settled, new conversion data are available as shown in Figure 53 and Table 14 (Pulse-sync mode).


Figure 53. Pulse-Sync and Continuous-Sync Timing With Single Synchronization

Table 14. Pulse-Sync Timing for Figure 53 and Figure 54

| PARAMETER |  | MIN | MAX |
| :--- | :--- | :---: | :---: |
| $t_{\text {CSDL }}$ | CLK rising edge to SYNC rising edge ${ }^{(1)}$ | 30 | -30 |
| $t_{\text {SYNC }}$ | SYNC clock period ${ }^{(2)}$ | ns |  |
| $\mathrm{t}_{\text {SPWH, }} \mathrm{L}$ | SYNC pulse width, high or low | 1 | Infinite |
| $\mathrm{t}_{\mathrm{DR}}$ | Time for data ready (SINC filter) | $\mathrm{f}_{\text {DATA }}$ |  |
|  | Time for data ready (FIR filter) | $1 / \mathrm{f}_{\mathrm{CLK}}$ |  |

[^0]Table 15. $\mathrm{t}_{\mathrm{DR}}$ Time for Data Ready (Sinc Filter)

| $\mathbf{f}_{\text {DATA }}(\mathbf{k S P S})$ | $\mathbf{f}_{\text {CLK }}$ CYCLES $^{(1)}$ |
| :---: | :---: |
| 128 | 440 |
| 64 | 616 |
| 32 | 968 |
| 16 | 1672 |
| 8 | 2824 |

(1) For SYNC and WAKEUP commands, number of $\mathrm{f}_{\mathrm{cLK}}$ cycles from next rising CLK edge directly after eighth rising SCLK edge to DRDY falling edge. For WAKEUP command only, subtract two $f_{\text {CLK }}$ cycles.
Table 15 is referenced by Table 14 and Table 17.
Observe the timing restriction of SYNC rising edge to CLK rising edge as shown in Figure 53 and Table 14. Synchronization occurs on the next rising CLK edge after the rising edge of the SYNC, or after the eighth rising SCLK edge when synchronized by command. To synchronize multiple ADCs by the sync command, broadcast the command to the ADCs simultaneously.

### 8.4.1.2 Continuous-Sync Mode

In continuous-sync mode, either a single synchronization pulse or a continuous synchronization clock may be applied. Use the SYNC pin in this mode. When a single sync pulse is applied (rising edge), the device resynchronizes the same way as pulse-sync mode. ADC re-synchronization occurs only when the time between SYNC rising edges is not an integer multiple of the conversion period. When resynchronization occurs, DRDY continues to toggle at the period of the date rate, and the DOUT output is held low until data are ready ( 63 DRDY periods later). At the 63rd reading, conversion data are valid, as shown in Figure 53.
If an additional pulse is applied to the SYNC pin, the elapsed time from the previous pulse must be an integral multiple of the output data rate otherwise re-synchronization results.
If a synchronization clock is applied to the SYNC pin, the device resynchronizes only under the condition $\mathrm{t}_{\text {SYNC }} \neq$ $\mathrm{N} / \mathrm{f}_{\text {DATA }}$, where $\mathrm{N}=1,2,3$, and so on. When re-synchronized, DRDY continues to strobe, but the data on DOUT is held low until new data are valid after filter reset. If the period of the synchronizing clock matches an integral multiple of the data rate, the ADC does not re-synchronize. Note that the phase of the applied clock and output data rate ( $\overline{\mathrm{DRDY}}$ ) is not aligned because of the initial delay of $\overline{\mathrm{DRDY}}$ after the SYNC clock is first applied. Figure 54 shows the timing for continuous-sync mode.


Figure 54. Continuous-Sync Timing With SYNC Clock
Apply the synchronization clock after the continuous-sync mode is programmed. The first rising edge of SYNC then results in synchronization. Note that subsequent writes to any ADC register results in re-synchronization at the time of the register write operation. The re-synchronization leads to loss of the previous synchronization. Send the STANDBY command followed by the WAKEUP command to re-establish the previous synchronization. Re-synchronization occurs is valid as long as the time between the STANDBY and WAKEUP commands is not a multiple integer of the conversion period by at least one clock cycle.

### 8.4.2 Reset (RESET Pin and Reset Command)

Reset the ADC in three ways: cycle the power supplies, toggle the $\overline{\text { RESET }}$ pin low, or send a RESET command. When using the RESET pin, take it low and hold for at least $2 / \mathrm{f}_{\mathrm{CLK}}$ to force a reset. The ADS1284 is held in reset until the pin is released. By reset command, reset takes effect on the next rising edge of $\mathrm{f}_{\text {CLK }}$ after the eighth rising edge of SCLK of the command. In order to make certain that the RESET command functions, the SPI interface may need to be reset; see the Serial Interface section.
When the ADS1284 is reset, registers are set to default and the conversions are synchronized on the next rising edge of CLK. New conversion data are available, as shown in Figure 55 and Table 16.


Figure 55. Reset Timing

Table 16. Reset Timing for Figure 55

| PARAMETER |  | MIN | UNIT |
| :--- | :--- | :---: | :---: |
| $\mathrm{t}_{\mathrm{CRHD}}$ | CLK to RESET hold time | 10 | ns |
| $\mathrm{t}_{\text {RCSU }}$ | RESET to CLK setup time | 10 | ns |
| $\mathrm{t}_{\text {RST }}$ | RESET low | 2 | $1 / \mathrm{f}_{\mathrm{CLK}}$ |
| $\mathrm{t}_{\mathrm{DR}}$ | Time for data ready | $62.98046875 / \mathrm{f}_{\text {DATA }}+468 / \mathrm{f}_{\mathrm{CLK}}$ |  |

### 8.4.3 Master Clock Input (CLK)

The ADS1284 requires a clock for operation. The specified clock frequency is 4.096 MHz and is applied to the CLK pin. The ADC data rates scale with clock frequency, however there is no benefit in noise reduction by reducing clock frequency; select a slower data to reduce noise.

As with any high-speed data converter, a high-quality, low-jitter clock is essential for optimum performance. Crystal clock oscillators are the recommended clock source. Make sure to avoid excess ringing on the clock input; keep the clock trace as short as possible and use a $50-\Omega$ series resistor close to the clock source.

### 8.4.4 Power-Down ( $\overline{\text { PWDN }}$ Pin and STANDBY Command)

Power-down the ADS1284 in two ways: take the PWDN pin low, or send a STANDBY command. When the $\overline{\text { PWDN }}$ pin is pulled low, the internal circuitry is disabled to minimize power and the contents of the register settings are reset.
When in the power-down state, the device outputs remain active and the device inputs must not float. When the STANDBY command is sent, the SPI port and the configuration registers are kept active. Figure 56 and Table 17 show the timing. Standby mode is cancelled when $\overline{\mathrm{CS}}$ is taken high.


Figure 56. $\overline{\text { PWDN Pin and Wake-Up Command Timing }}$ (Table 17 shows $\mathrm{t}_{\mathrm{DR}}$ )

Table 17. Power-On, $\overline{\text { PWDN Pin, and Wake-Up Command Timing for New Data }}$

| PARAMETER |  |  | FILTER MODE |
| :---: | :---: | :---: | :---: |
| $t_{\text {DR }}$ | Time for data ready $2^{16}$ CLK cycles after power-on; and new data ready after PWDN pin or WAKEUP command | See Table 15 | SINC ${ }^{(1)}$ |
|  |  | $62.98046875 / \mathrm{f}_{(2)}^{(2)} \mathrm{dATA}+468 / \mathrm{f}_{\mathrm{CLK}}$ | FIR |

(1) Supply power-on and PWDN pin default is 1000 SPS FIR.
(2) Subtract two CLK cycles for the WAKEUP command. The WAKEUP command is timed from the next rising edge of CLK to after the eighth rising edge of SCLK during command to $\overline{\text { DRDY }}$ falling.

### 8.4.5 Power-On Sequence

The ADS1284 has three power supplies: AVDD, AVSS, and DVDD. Figure 57 shows the power-on sequence of the ADS1284. The power supplies can be sequenced in any order. The supplies [the difference of AVDD AVSS, and DVDD] generate signals that are ANDed together to generate reset. After the supplies have crossed the power-on reset thresholds, $2^{16} \mathrm{f}_{\text {cLK }}$ cycles are counted before releasing the internal reset. After the internal reset is released, new conversion data are available, as shown in Figure 57 and Table 17.


Figure 57. Power-On Sequence

### 8.4.6 DVDD Power Supply

The DVDD supply operates over the range of 1.65 V to 3.6 V . If operating DVDD at less than 2.25 V , connect the DVDD pin directly to the BYPAS pin. Figure 58 shows the required connection if DVDD $<2.25 \mathrm{~V}$. Otherwise if operating DVDD > 2.25 V , do not connect the pins together.


Figure 58. DVDD Power

### 8.4.7 Serial Interface

A serial interface is used to read both the conversion data and to access the configuration registers. The interface is SPI-compatible and consists of four signals: $\overline{C S}$, SCLK, DIN, and DOUT. Up to 15 ADCs converting at 4 kSPS can share a common serial bus when operating SCLK at 2.048 MHz .

### 8.4.7.1 Chip Select ( $\overline{C S}$ )

Chip select ( $\overline{\mathrm{CS}}$ ) is an active-low input that enables the ADC serial interface for data transfer. $\overline{\mathrm{CS}}$ low enables communication. $\overline{\text { CS }}$ high disables communication. When communication is disabled, DOUT (output data pin) is high impedance (tristate mode). Additionally, SCLK activity is ignored, and data transfers or commands in progress are reset. $\overline{C S}$ must remain low for the duration of the data transfer with the ADC. $\overline{C S}$ can be tied low, which permanently enables the ADC serial interface. When $\overline{\mathrm{CS}}$ goes high, the ADC idle mode (STANDBY) and stop read data continuous (SDATAC) modes are cancelled. See the SDATAC Requirements section for more information about SDATAC mode.

### 8.4.7.2 Serial Clock (SCLK)

The serial clock (SCLK) is a digital input that is used to clock data into (DIN) and out of (DOUT) the ADC. SCLK is a Schmitt-trigger input that has a high degree of noise immunity. However, keep the SCLK signal as clean as possible to prevent possible glitches from inadvertently shifting the data. Data are shifted into DIN on the rising edge of SCLK and data are shifted out of DOUT on the falling edge of SCLK. Keep SCLK low when not active. SCLK is ignored when $\overline{C S}$ is high.

### 8.4.7.3 Data Input (DIN)

The data input pin (DIN) is used to input register data and commands to the ADS1284. Keep DIN low when reading conversion data in the read-data-continuous mode (except when issuing a SDATAC command). Data on DIN are shifted into the converter on the rising edge of SCLK.

### 8.4.7.4 Data Output (DOUT)

The data output pin (DOUT) is used to output data from the ADS1284. Data are shifted out on the falling edge of SCLK. When CS is high, the DOUT pin is in tristate.

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### 8.4.7.5 Serial Port Auto Timeout

The serial interface is reset each time $\overline{\mathrm{CS}}$ is taken high. However, for applications that tie $\overline{\mathrm{CS}}$ low, the serial port cannot be reset by taking $\overline{\mathrm{CS}}$ high. The ADS1284 provides a feature that automatically recovers the interface when a transmission is stopped or interrupted, or if a noise glitch appears on SCLK. To reset the serial interface remotely, hold SCLK low for 64 DRDY cycles. The reset of the serial interface results in termination of data transfer or commands in progress. After serial interface reset occurs, the next SCLK pulse starts a new communication cycle. To prevent remote reset of the interface, pulse SCLK at least once for every 64 DRDY pulses.

### 8.4.7.6 Data Ready ( $\overline{D R D Y}$ )

$\overline{\mathrm{DRDY}}$ is an output that is driven low when new conversion data are ready fir retrieval, as shown in Figure 59. When reading data in continuous mode, the read operation must be completed before four CLK periods before the next falling DRDY goes low again, or the data are overwritten with new conversion data. When reading data in command mode, the read operation can overlap the occurrence of the next DRDY without data corruption.


Figure 59. $\overline{\text { DRDY }}$ With Data Retrieval
$\overline{\mathrm{DRDY}}$ resets high on the first falling edge of SCLK. Figure 59 and Figure 60 show the function of $\overline{\mathrm{DRDY}}$ with and without data readback, respectively.
If data are not retrieved (no SCLK provided), $\overline{\text { DRDY }}$ pulses high for four $\mathrm{f}_{\text {CLK }}$ periods during the update time, as shown in Figure 60.
$\overline{\mathrm{DRDY}}$ remains active when $\overline{\mathrm{CS}}$ is high.


Figure 60. $\overline{\text { DRDY }}$ With No Data Retrieval

### 8.4.8 Data Format

The ADS1284 output data is 32 -bits in binary twos complement format, as shown in Table 18. The LSB of the data is a redundant sign bit: 0 for positive numbers and 1 for negative numbers. However, when the output is clipped to + FS, the LSB $=1$, and when the output is clipped to -FS , the $\mathrm{LSB}=0$. If desired, the data readback can be stopped at 24 bits. Note that in sinc-filter mode, the output data are scaled by $1 / 2$.

Table 18. Ideal Output Code Versus Input Signal

| INPUT SIGNAL $\mathrm{V}_{\text {IN }}$ (AINP - AINN) | 32-BIT IDEAL OUTPUT CODE ${ }^{(1)}$ |  |
| :---: | :---: | :---: |
|  | FIR FILTER | SINC FILTER ${ }^{(2)}$ |
| $>\frac{\mathrm{V}_{\mathrm{REF}}}{2 \times \mathrm{PGA}}$ | 7FFFFFFFh | See note ${ }^{(3)}$ |
| $\frac{\mathrm{V}_{\mathrm{REF}}}{2 \times \mathrm{PGA}}$ | 7FFFFFFEh | 3FFFFFFFh |
| $\frac{\mathrm{V}_{\mathrm{REF}}}{2 \mathrm{PGA} \times\left(2^{30}-1\right)}$ | 00000002h | 00000001h |
| 0 | 00000000h | 00000000h |
| $\frac{-\mathrm{V}_{\text {REF }}}{2 \mathrm{PGA} \times\left(2^{30}-1\right)}$ | FFFFFFFFh | FFFFFFFFh |
| $\frac{-\mathrm{V}_{\mathrm{REF}}}{2 \mathrm{PGA}} \times \frac{2^{30}}{2^{30}-1}$ | 80000001h | C0000000h |
| $<\frac{-\mathrm{V}_{\text {REF }}}{2 \mathrm{PGA}} \times \frac{2^{30}}{2^{30}-1}$ | 80000000h | See note ${ }^{(3)}$ |

(1) Excludes effects of noise, linearity, offset, and gain errors.
(2) Due to the reduction in oversampling ratio (OSR) related to high data rates, full 32 -bit resolution is not be available in sinc filter mode.
(3) In sinc-filter mode, the output does not clip at corresponding positive or negative code when the full-scale range is exceeded.

### 8.4.9 Reading Data

The ADS1284 provides two modes to read conversion data: read-data-continuous mode and read-data-bycommand mode.

### 8.4.9.1 Read-Data-Continuous Mode

In the read-data-continuous mode, conversion data are read from the ADC without need for the read command. This mode is the default mode at power-on. This mode is also enabled by the RDATAC command. When DRDY goes low, indicating that new data are available, the MSB of data is placed on DOUT, as shown in Figure 61. The data are read (latched) by the user on the rising edges of SCLK. At the first falling edge of SCLK, DRDY returns high. After 32 bits of data have been read, further SCLK transitions cause DOUT to go low. If desired, the read operation may be stopped at 24 bits. The entire data shift operation must be completed within four CLK periods before DRDY falls again or the data may be corrupted.
When a SDATAC command is issued, the $\overline{\text { DRDY }}$ output is blocked but the ADS1284 continues conversions. In stop continuous mode, the data is read by command.

(1) DOUT is in tristate when $\overline{\mathrm{CS}}$ is high. $\overline{\mathrm{CS}}$ can be tied low. See Figure 1 for $\overline{\mathrm{CS}}$ low to valid DOUT propagation time.

Figure 61. Read Data Continuous

Table 19. Timing Data for Figure 61

| PARAMETER |  | MIN | TYP |
| :--- | :--- | :---: | :---: |
| $\mathrm{t}_{\text {DDPD }}$ | $\overline{\text { DRDY }}$ to valid MSB on DOUT propagation delay ${ }^{(1)}$ | MAX | UNIT |

(1) DOUT is in tristate when $\overline{\mathrm{CS}}$ is high. Load on DOUT $=20 \mathrm{pF} \| 100 \mathrm{k} \Omega$.

### 8.4.9.2 Read-Data-By-Command Mode

Read-data-continuous mode is stopped by the SDATAC command and then places the ADC into read-data-bycommand mode. In read-data-by-command mode, an RDATA command is sent to the device in order to read each new conversion data (as shown in Figure 62). When the read data command is received (on the eighth SCLK rising edge), data are available to read only when $\overline{\text { DRDY }}$ subsequently goes low ( $t_{\text {DR }}$ ). When $\overline{\mathrm{DRDY}}$ goes low, conversion data appear on DOUT. The data may be read on the rising edge of SCLK.

(1) DOUT is in tristate when $\overline{\mathrm{CS}}$ is high. $\overline{\mathrm{CS}}$ can be tied low. See Figure 1 for $\overline{\mathrm{CS}}$ low to SCLK rising edge time.

Figure 62. Read Data By Command, RDATA (t ${ }_{\text {DDPD }}$ timing is given in Table 19)
Table 20. Read Data Timing for Figure 62

| PARAMETER |  |  |  |  |  |  |  |  | MIN | TYP | MAX | UNIT |
| :---: | :--- | ---: | ---: | ---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{DR}}$ | Time for new data after data read command | 0 | 1 | $\mathrm{f}_{\mathrm{DATA}}$ |  |  |  |  |  |  |  |  |

### 8.4.10 One-Shot Operation

The ADS1284 can perform very power-efficient, one-shot conversions using the STANDBY command while under software control. Figure 63 shows this sequence. First, issue the STANDBY command to set the standby mode.
When ready to make a measurement, issue the WAKEUP command. When $\overline{\text { DRDY }}$ goes low, the fully-settled conversion data are ready and can be read directly in read-data-continuous mode. Afterwards, issue another STANDBY command. When ready for the next measurement, repeat the cycle starting with another WAKEUP command.


See Figure 56 and Table 17 for time to new data.
Figure 63. One-Shot Conversions Using the STANDBY Command

### 8.4.11 Offset and Full-Scale Calibration Registers

The conversion data can be scaled for offset and gain before yielding the final output code. As shown in Figure 64, the output of the digital filter is first subtracted by the offset register (OFC) and then multiplied by the full-scale register (FSC). Equation 15 shows the scaling:

Final Output Data $=($ Input - OFC[2:0] $) \times \frac{\text { FSC[2:0] }}{400000 \mathrm{~h}}$
The values of the offset and full-scale registers are set by writing to them directly, or they are set automatically by the calibration commands.
The offset and full-scale calibrations apply to specific PGA settings. When the PGA is changed, these registers generally require recalculation. Calibration is bypassed in the sinc filter mode.


Figure 64. Calibration Block Diagram

### 8.4.11.1 OFC[2:0] Registers

The 24-bit offset calibration word is composed of three 8-bit registers, as shown in Table 21. The offset register is left-justified to align with the 32 bits of conversion data. The offset is in twos complement format with a maximum positive value of 7FFFFFh and a maximum negative value of 800000 h . This value is subtracted from the conversion data. A register value of 00000h has no offset correction (default value).

Table 21. Offset Calibration Word

| REGISTER | BYTE | BIT ORDER |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFC0 | LSB | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 (LSB) |
| OFC1 | MID | B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
| OFC2 | MSB | B23 (MSB) | B22 | B21 | B20 | B19 | B18 | B17 | B16 |

Although the offset calibration register value can correct offsets ranging from -FS to +FS (as shown in Table 22), in order to avoid input overload, do not exceed the maximum input voltage range of $106 \%$ FSR (including calibration).

Table 22. Offset Calibration Values

| OFC REGISTER | FINAL OUTPUT CODE(1) |
| :---: | :---: |
| 7FFFFFh | 80000000 h |
| 000001 h | FFFFFF00h |
| 000000 h | 00000000 h |
| FFFFFFh | 00000100 h |
| 800000 h | 7FFFFF00h |

(1) Full 32-bit final output code with zero code input.

### 8.4.11.2 FSC[2:0] Registers

The full-scale calibration is a 24 -bit word, composed of three 8 -bit registers, as shown in Table 23. The full-scale calibration value is 24 -bit, straight offset binary, normalized to 1.0 at code 400000 h .

Table 23. Full-Scale Calibration Word

| REGISTER | BYTE | BIT ORDER |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FSC0 | LSB | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 (LSB) |
| FSC1 | MID | B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
| FSC2 | MSB | B23 (MSB) | B22 | B21 | B20 | B19 | B18 | B17 | B16 |

Table 24 summarizes the scaling of the full-scale register. A register value of 400000 h (default value) has no gain correction (gain =1). Although the full-scale calibration register value corrects gain errors above one (gain correction < 1), the full-scale range of the analog inputs must not exceed 106\% FSR (including calibration) in order to avoid input overload.

Table 24. Full-Scale Calibration Register Values

| FSC REGISTER | GAIN CORRECTION |
| :---: | :---: |
| 800000 h | 2.0 |
| 400000 h | 1.0 |
| 200000 h | 0.5 |
| 000000 h | 0 |

### 8.4.12 Calibration Commands (OFSCAL and GANCAL)

Use the calibration commands (OFSCAL or GANCAL) to calibrate the conversion data. The values of the offset and gain calibration registers are internally written to perform calibration. The appropriate input signals must be applied to the ADS1284 inputs before sending the commands. Use slower data rates to achieve more consistent calibration results; this effect is a byproduct of the lower noise that these data rates provide. Also, if calibrating at power-on, be sure the reference voltage is fully settled.
Figure 65 shows the calibration command sequence. After the analog input voltage (and reference) have stabilized, send the SDATAC command, followed by the SYNC and RDATAC commands. DRDY goes low after 64 data periods. After DRDY goes low, send the SDATAC command, then the calibrate command (OFSCAL or GANCAL), followed by the RDATAC command. After 16 data periods, calibration is complete and conversion data can be read at this time. The SYNC input must remain high during the calibration sequence.


Figure 65. Offset and Gain Calibration Timing
The calibration commands apply to specific PGA settings. If the PGA is changed, recalibration is necessary. Calibration is bypassed in the sinc filter mode.

### 8.4.12.1 OFSCAL Command

The OFSCAL command performs an offset calibration. Before sending the OFSCAL command sequence (Figure 65), a zero input signal must be applied to the ADS1284 and the inputs allowed to stabilize. When the command sequence (Figure 65) is sent, the ADS1284 averages 16 readings, and then writes this value to the OFC register. The contents of the OFC register can be subsequently read or written. During offset calibration, the full-scale correction is bypassed. Use the OFSCAL command to calibrate the optional $100-\mathrm{mV}$ offset.

### 8.4.12.2 GANCAL Command

The GANCAL command performs a gain calibration. Before sending the GANCAL command sequence (Figure 65), a dc input must be applied (typically full-scale input, but not to exceed $106 \%$ full-scale). After the signal has stabilized, the command sequence can be sent. The ADS1284 averages 16 readings, then computes a gain value that scales the applied calibration voltage to full-scale. The gain value is written to the FSC register, where the contents are subsequently read or written.

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### 8.4.13 User Calibration

System calibration of the ADS1284 can be performed without using the calibration commands. This procedure requires the calibration values to be externally calculated and then written to the calibration registers. The steps for this procedure are:

1. Set the OFSCAL[2:0] register $=0 \mathrm{~h}$, and GANCAL[2:0] $=400000 \mathrm{~h}$. These values set the offset and gain registers to 0 and 1 , respectively.
2. Apply a zero differential input to the input of the system. Wait for the system to settle and then average the output readings. Higher numbers of averaged readings result in more consistent calibration. Write the averaged value to the OFC register.
3. Apply a differential dc signal, or an ac signal (typically full-scale, but do not exceed $106 \%$ FSR). Wait for the system to settle and then average the output readings.
The value written to the FSC registers is calculated by Equation 16 or Equation 17.
DC-signal calibration is shown in Equation 16. The expected output code is based on 31-bit output data.

$$
\begin{equation*}
\text { FSC[2:0] }=400000 \mathrm{~h} \times\left(\frac{\text { Expected Output Code }}{\text { Actual Output Code }}\right) \tag{16}
\end{equation*}
$$

For ac-signal calibration, use an RMS value of collected data, as shown in Equation 17:

$$
\begin{equation*}
\text { FSC }[2: 0]=400000 \mathrm{~h} \times \frac{\text { Expected RMS Value }}{\text { Actual RMS Value }} \tag{17}
\end{equation*}
$$

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### 8.5 Programming

### 8.5.1 Commands

The commands listed in Table 25 control the operation of the ADS1284. Most commands are stand-alone (that is, one byte in length); the register read and write commands are two bytes long in addition to the actual register data bytes.

Table 25. Command Descriptions

| COMMAND | TYPE | DESCRIPTION | 1st COMMAND BYTE ${ }^{(1)(2)}$ | 2nd COMMAND BYTE ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: |
| WAKEUP | Control | Wake-up from standby mode | 0000 000X (00h or 01h) |  |
| STANDBY | Control | Enter standby mode | 0000 001X (02h or 03h) |  |
| SYNC | Control | Synchronize the analog-to-digital conversion | 0000 010X (04h or 5h) |  |
| RESET | Control | Reset registers to default values | 0000 011X (06h or 07h) |  |
| RDATAC | Control | Enter read data continuous mode | 00010000 (10h) |  |
| SDATAC | Control | Stop read data continuous mode | 00010001 (11h) |  |
| RDATA | Data | Read data by command ${ }^{(4)}$ | 00010010 (12h) |  |
| RREG | Register | Read nnnnn register(s) at address $r r r r{ }^{(4)}$ | $001 r r r r r(20 h+000 r ~ r r r r) ~$ | 000n nnnn (00h + n nnnn) |
| WREG | Register | Write nnnnn register(s) at address rrrrr | $010 r r r r r(40 \mathrm{~h}+000 r r r r r)$ | 000n nnnn (00h + n nnnn) |
| OFSCAL | Calibration | Offset calibration | 01100000 (60h) |  |
| GANCAL | Calibration | Gain calibration | 01100001 (61h) |  |

(1) $X=$ don't care.
(2) $\quad r r r r=$ starting address for register read and write commands.
(3) $n n n n n=$ number of registers to be read from or written to -1 . For example, to read from or write to three registers, set $n n n n n=2$ (00010).
(4) Required to cancel read-data-continuous mode before sending a command.
$\overline{\mathrm{CS}}$ must remain low for duration of the command-byte sequence. A delay of $24 \mathrm{f}_{\mathrm{CLK}}$ cycles between commands and between bytes within a command is required, starting from the last SCLK rising edge of one command to the first SCLK rising edge of the following command. The required delay is shown in Figure 66.

(1) $\mathrm{t}_{\text {SCLKDLY }}=24 / \mathrm{f}_{\text {CLK }}(\mathrm{min})$.

Figure 66. Consecutive Commands

### 8.5.1.1 SDATAC Requirements

In read-data-continuous mode, the ADS1284 places conversion data on the DOUT pin as SCLK is applied. As a result of the potential conflict between conversion data and register data placed on DOUT resulting from a RREG or RDATA operation, it is necessary to send a stop-read-data-continuous (SDATAC) command before a RREG or RDATA command. The SDATAC command disables the direct output of conversion data on the DOUT pin. $\overline{\mathrm{CS}}=1$ cancels SDATAC mode; therefore, keep $\overline{\mathrm{CS}}$ held low after sending the SDATAC command to the next RREG or RDATA command.

### 8.5.1.2 WAKEUP: Wake-Up From Standby Mode

The WAKEUP command is used to exit the standby mode. After sending this command, the time for the first data to be ready is illustrated in Figure 56 and Table 18. Sending this command during normal operation has no effect; for example, reading data by the read-data-continuous mode with DIN held low.

### 8.5.1.3 STANDBY: Standby Mode

The STANDBY command places the ADS1284 into standby mode. In standby, the device enters a reduced power state where a low quiescent current remains to keep the register settings and serial interface active. The ADC remains in standby mode until CS is taken high or the WAKEUP command is sent. For complete device shutdown, take the PWDN pin low (register settings are not saved). The operation of standby mode is shown in Figure 67.


Figure 67. STANDBY Command Sequence

### 8.5.1.4 SYNC: Synchronize the Analog-to-Digital Conversion

The SYNC command synchronizes the analog-to-digital conversion. Upon receiving the command, the reading in progress is cancelled and the conversion process is restarted. In order to synchronize multiple ADS1284s, the command must be sent simultaneously to all devices. The SYNC pin must be held high during this command.

### 8.5.1.5 RESET: Reset the Device

The RESET command resets the registers to default values, enables read-data-continuous mode, and restarts the conversion process. The RESET command is functionally equivalent to taking the RESET pin low. See Figure 55 for the RESET command timing.

### 8.5.1.6 RDATAC: Read Data Continuous

The RDATAC command enables read-data-continuous mode (default mode). In this mode, conversion data is read from the device directly without the need to supply a data read command. Each time DRDY falls low, new data are available to read. See the Read-Data-Continuous Mode section for more details.

### 8.5.1.7 SDATAC: Stop Read Data Continuous

The SDATAC command stops read-data-continuous mode. Exit read-data-continuous mode before sending register and data read commands. The SDATAC command suppresses the DRDY output, but the ADS1284 continues conversions. Take $\overline{\mathrm{CS}}$ high to cancel SDATAC mode.

### 8.5.1.8 RDATA: Read Data by Command

The RDATA command reads the conversion data. See the Read-Data-By-Command Mode section for more details.

### 8.5.1.9 RREG: Read Register Data

The RREG command is used to read single- or multiple-register data. The command consists of a two-byte opcode argument, followed by the output of register data. The first byte of the opcode includes the starting address, and the second byte specifies the number of registers to read minus one.

First command byte: 001r rrrr, where rrrrr is the starting address of the first register.
Second command byte: 000 n nnnn, where nnnnn is the number of registers to read minus one.
Starting with the 16th falling edge of SCLK, the register data appear on DOUT. Read the data on the 17th SCLK rising edge.
The RREG command is illustrated in Figure 68.
A delay of $24 \mathrm{f}_{\text {CLK }}$ cycles is required between each byte transaction.


Figure 68. Read Register Data (Table 26 shows $\mathrm{t}_{\mathrm{DLY}}$ )

Table 26. $\mathrm{t}_{\mathrm{DRY}}$ Value

| PARAMETER | MIN |
| :---: | :---: |
| $\mathrm{t}_{\text {DLY }}$ | $24 / \mathrm{f}_{\text {CLK }}$ |

### 8.5.1.10 WREG: Write to Register

The WREG command writes single- or multiple-register data. The command consists of a two-byte op-code argument followed by the input of register data. The first byte of the op-code contains the starting address and the second byte specifies the number of registers to write minus one.
First command byte: 010r rrrr, where rrrrr is the starting address of the first register.
Second command byte: 000 n nnnn, where nnnnn is the number of registers to write minus one.
Data byte(s): one or more register data bytes, depending on the number of registers specified.
Figure 69 illustrates the WREG command.
A delay of $24 \mathrm{f}_{\text {CLK }}$ cycles is required between each byte transaction.


Example: Write six registers, starting at register 05h (OFC0)
Command Byte $1=01000101$
Command Byte $2=00000101$
(1) $\overline{\mathrm{CS}}$ can be tied low. See Figure 1 for $\overline{\mathrm{CS}}$ low to SCLK rising edge time.

Figure 69. Write Register Data (Table 26 shows $\mathrm{t}_{\mathrm{DLY}}$ )

### 8.5.1.11 OFSCAL: Offset Calibration

The OFSCAL command performs an offset calibration. The inputs to the converter (or the inputs to the external preamplifier) should be zeroed and allowed to stabilize before sending this command. The offset calibration register updates after this operation. See the Calibration Commands section for more details.

### 8.5.1.12 GANCAL: Gain Calibration

The GANCAL command performs a gain calibration. The inputs to the converter should have a stable dc input (typically full-scale, but not to exceed 106\% full-scale). The gain calibration register updates after this operation. See the Calibration Commands section for more details.

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### 8.6 Register Maps

Collectively, the registers contain all the information needed to configure the device, such as data rate, filter selection, calibration, and more. The registers are accessed by the RREG and WREG commands. The registers can be accessed individually or as a block of registers by sending or receiving consecutive bytes. After a register write operation, the ADC resets, resulting in an interruption of 63 readings.

Table 27. Register Map

| ADDRESS | REGISTER | RESET <br> VALUE | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 00h | ID_CFG | X0h | ID3 | ID2 | ID1 | ID0 | 0 | 0 | OFFSET1 | OFFSET0 |
| 01h | CONFIG0 | 52h | SYNC | MODE | DR2 | DR1 | DR0 | PHASE | FILTR1 | FILTR0 |
| 02h | CONFIG1 | 08h | 0 | MUX2 | MUX1 | MUX0 | CHOP | PGA2 | PGA1 | PGA0 |
| 03h | HPF0 | 32h | HPF07 | HPF06 | HPF05 | HPF04 | HPF03 | HPF02 | HPF01 | HPF00 |
| 04h | HPF1 | 03h | HPF15 | HPF14 | HPF13 | HPF12 | HPF11 | HPF10 | HPF09 | HPF08 |
| 05h | OFC0 | 00h | OFC07 | OFC06 | OFC05 | OFC04 | OFC03 | OFC02 | OFC01 | OFC00 |
| 06h | OFC1 | 00h | OFC15 | OFC14 | OFC13 | OFC12 | OFC11 | OFC10 | OFC09 | OFC08 |
| 07h | OFC2 | 00h | OFC23 | OFC22 | OFC21 | OFC20 | OFC19 | OFC18 | OFC17 | OFC16 |
| 08h | FSC0 | 00h | FSC07 | FSC06 | FSC05 | FSC04 | FSC03 | FSC02 | FSC01 | FSC00 |
| 09h | FSC1 | 00h | FSC15 | FSC14 | FSC13 | FSC12 | FSC11 | FSC10 | FSC09 | FSC08 |
| OAh | FSC2 | 40h | FSC23 | FSC22 | FSC21 | FSC20 | FSC19 | FSC18 | FSC17 | FSC16 |

### 8.6.1 Register Descriptions

### 8.6.1.1 ID_CFG: ID_Configuration Register (address = 00h) [reset =x0h]

Figure 70. ID_CFG Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ID3 | ID2 | ID1 | ID0 | 0 | 0 | OFFSET1 | OFFSET0 |
| R-xh | R-xh | R-xh | R-xh | R/W-Oh | R/W-0h | R/W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $R=$ Read only; $-n=$ value after reset

## Bit[7:4] ID[3:0]

Factory-programmed identification bits (read-only). The ID bits are subject to change without notification.
Bit[3:2]
Reserved
Always write 00
Bit[1:0] OFFSET[1:0] (see Offset section)
00: Offset disabled (default)
01: Reserved
10: Offset $=100 /$ PGA mV
11: Offset $=75 /$ PGA mV

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### 8.6.1.2 CONFIGO: Configuration Register 0 (address $=01 \mathrm{~h}$ ) [reset $=52 \mathrm{~h}]$

Figure 71. CONFIGO Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SYNC | MODE | DR2 | DR1 | DR0 | PHASE | FILTR1 |
| R/W-0h | R/W-1h | R/W-0h | R/W-1h | R/W-0h | R/W-0h | R/W -1h |

LEGEND: R/W = Read/Write; R = Read only; $-\mathrm{n}=$ value after reset

Bit[7]

## SYNC

Synchronization mode bit.
0 : Pulse-sync mode (default)
1: Continuous-sync mode
Bit[6] MODE
Mode Control
0: Low-power mode
1: High-resolution mode (default)
Bit[5:3] DR[2:0]
Data rate select bits.
000: 250 SPS
001: 500 SPS
010: 1000 SPS (default)
011: 2000 SPS
100: 4000 SPS
Bit[2]
PHASE
FIR phase response bit.
0 : Linear phase (default)
1: Minimum phase
Bit[1:0] FILTR[1:0]
Digital filter configuration bits.
00: Reserved
01: Sinc filter block only
10: Sinc + LPF filter blocks (default)
11: Sinc + LPF + HPF filter blocks

### 8.6.1.3 CONFIG1: Configuration Register 1 (address $=02 \mathrm{~h}$ ) [reset $=08 \mathrm{~h}]$

Figure 72. CONFIG1 Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | MUX2 | MUX1 | MUX0 | CHOP | PGA2 | PGA1 |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-1h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; R = Read only; $-\mathrm{n}=$ value after reset

Bit[7]

Bit[6:4]

## Reserved

Always write 0
MUX[2:0]
MUX select bits.
000: AINP1 and AINN1 (default)
001: AINP2 and AINN2
010: Internal short through 400- $\Omega$ resistor
011: AINP1 and AINN1 connected to AINP2 and AINN2
100: External short to AINN2
Bit[3]
CHOP
PGA chopping enable bit.
0 : PGA chopping disabled
1: PGA chopping enabled (default)
Bit[2:0] PGA[2:0]
PGA gain select bits.
000: $G=1$ (default)
001: $G=2$
010: $G=4$
011: $G=8$
100: $G=16$
101: $G=32$
110: $G=64$

### 8.6.1.4 HPFO and HPF1 Registers

These two bytes (high-byte and low-byte, respectively) set the corner frequency of the high-pass filter.
8.6.1.4.1 HPFO: High-Pass Filter Corner Frequency, Low Byte (address $=03 \mathrm{~h}$ ) [reset $=\mathbf{3 2 h}$ ]

Figure 73. HPFO Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HPF07 | HPF06 | HPF05 | HPF04 | HPF03 | HPF02 | HPF01 |
| R/W-0h | R/W-0h | R/W-1h | R/W-1h | R/W-0h | R/W-0h | R/W-1h |

LEGEND: R/W = Read/Write; $\mathrm{R}=$ Read only; $-\mathrm{n}=$ value after reset
8.6.1.4.2 HPF1: High-Pass Filter Corner Frequency, High Byte (address $=04 \mathrm{~h})$ [reset $=03 \mathrm{~h}]$

Figure 74. HPF1 Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HPF15 | HPF14 | HPF13 | HPF12 | HPF11 | HPF10 | HPF09 | HPF08 |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-1h | 1R/W-1h |

LEGEND: R/W = Read/Write; $\mathrm{R}=$ Read only; $-\mathrm{n}=$ value after reset

### 8.6.1.5 OFCO, OFC1, OFC2 Registers

These three bytes set the offset calibration value.
8.6.1.5.1 OFCO: Offset Calibration, Low Byte (address $=05 \mathrm{~h}$ ) [reset $=00 \mathrm{~h}]$

Figure 75. OFCO Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFC07 | OFC06 | OFC05 | OFC04 | OFC03 | OFC02 | OFC01 | OFC00 |
| R/W-Oh | R/W-Oh | R/W-Oh | R/W-Oh | R/W-Oh | R/W-Oh | R/W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; R = Read only; $-\mathrm{n}=$ value after reset
8.6.1.5.2 OFC1: Offset Calibration, Mid Byte (address $=06 \mathrm{~h}$ ) [reset $=00 \mathrm{~h}]$

Figure 76. OFC1 Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFC15 | OFC14 | OFC13 | OFC12 | OFC11 | OFC10 | OFC09 | OFC08 |
| R/W-Oh | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{R}=$ Read only; $-\mathrm{n}=$ value after reset
8.6.1.5.3 OFC2: Offset Calibration, High Byte (address $=07 \mathrm{~h}$ ) [reset $=00 \mathrm{~h}]$

Figure 77. OFC2 Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFC23 | OFC22 | OFC21 | OFC20 | OFC19 | OFC18 | OFC17 | OFC16 |
| R/W-Oh | R/W-0h | R/W-0h | R/W-0h | R/W-Oh | R/W-0h | R/W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; R = Read only; $-\mathrm{n}=$ value after reset

### 8.6.1.6 FSCO, FSC1, FSC2 Registers

These three bytes set the full-scale calibration value.

### 8.6.1.6.1 FSCO: Full-Scale Calibration, Low Byte (address $=08 \mathrm{~h}$ ) [reset $=00 \mathrm{~h}]$

Figure 78. FSCO Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FSC07 | FSC06 | FSC05 | FSC04 | FSC03 | FSC02 | FSC01 |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; R = Read only; $-\mathrm{n}=$ value after reset

### 8.6.1.6.2 FSC1: Full-Scale Calibration, Mid Byte (address $=09 \mathrm{~h}$ ) [reset $=00 \mathrm{~h}]$

Figure 79. FSC1 Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FSC15 | FSC14 | FSC13 | FSC12 | FSC11 | FSC10 | FSC09 | FSC08 |
| R/W-Oh | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{R}=$ Read only; $-\mathrm{n}=$ value after reset

### 8.6.1.6.3 FSC2: Full-Scale Calibration, High Byte (address $=0 \mathrm{Ah}$ ) [reset $=40 \mathrm{~h}]$

Figure 80. FSC2 Register

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FSC23 | FSC22 | FSC21 | FSC20 | FSC19 | FSC18 | FSC17 | FSC16 |
| R/W-0h | R/W-1h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; R = Read only; $-\mathrm{n}=$ value after reset

## 9 Application and Implementation

## NOTE

Information in the following applications sections is not part of the Tl component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The ADS1284 is a very high-resolution ADC with two modes of operation that provide tradeoffs between power consumption and SNR performance. Optimal performance requires giving special attention to the support circuitry and printed circuit board (PCB) design. Locate noisy digital components (such as microcontrollers, oscillators, and so on) in an area of the PCB away from the converter and front-end components. Keep the digital current path short and separate from sensitive analog components by placing the digital components close to the power-entry point.

### 9.2 Typical Applications

### 9.2.1 Geophone Interface

A typical geophone front-end application is shown in Figure 81. The application diagram shows the ADS1284 operation with dual $\pm 2.5-\mathrm{V}$ analog supplies. The ADS1284 can also operate with a single $5-\mathrm{V}$ analog supply.

(1) Optional external diode clamps.
(2) Optional reference noise filter.

Figure 81. Geophone Interface Application

## Typical Applications (continued)

The geophone input signal is filtered by both a differential filter (components $C_{4}$ and $R_{1}$ to $R_{4}$ ) and by commonmode filters (components $\mathrm{C}_{2}, \mathrm{C}_{3}$ and $\mathrm{R}_{1}, \mathrm{R}_{2}$ ). The differential filter removes high-frequency normal-mode components from the input signal. The common-mode filters remove high-frequency components that are common to both input leads. The input filters are not required for all applications; check the system requirements for each application.
Resistors $R_{5}$ and $R_{6}$ bias the signal input to the midsupply point (ground). For single-supply operation, set the bias to a low impedance midsupply point (AVDD / $2=2.5 \mathrm{~V}$ ).
Optional diode clamps protect the ADS1284 inputs from high-level voltage transients and overloads. The diodes provide additional protection if possible high-level input transients and surges exceed the ADC internal ESD diode rating.
The REF5050 5-V reference provides the reference to the ADC. An optional filter network $®_{7}$ and $C_{5}$ ) reduces the in-band reference noise for improved dynamic performance. However, the RC filter network increases the filter settling-time (from seconds to possibly minutes) depending on the dielectric absorption properties of capacitor $\mathrm{C}_{5}$. Capacitor $\mathrm{C}_{7}$ is mandatory and provides high-frequency bypassing of the reference inputs; place $\mathrm{C}_{7}$ as close as possible to the ADS1284 pins. Resistor $\mathrm{R}_{7}(1 \mathrm{k} \Omega)$ results in a $1 \%$ systematic gain error. Multiple ADCs can share a single reference, but if shared, use independent reference filters for each ADC.

As an alternative, the REF5045 (4.5 V) reference can be used. The REF5045 reference has the advantage of operating directly from the $5-\mathrm{V}$ (total) power supply; however, the $4.5-\mathrm{V}$ reference reduces signal range by $10 \%$ and results in a $1-\mathrm{dB}$ loss of SNR.

Capacitor $\mathrm{C}_{6}$ ( 10 nF ) filters the PGA output glitches caused by sampling of the modulator. This capacitor also forms an antialias filter with a low-pass cutoff frequency of 26 kHz .

## Typical Applications (continued)

### 9.2.2 Digital Interface

Figure 82 shows the digital connection to a controller (field programmable gate array or microcontroller). In this example, two ADCs are shown connected to one controller. The ADCs share the same serial interface (SCLK, DIN, and DOUT). The ADC is selected for communication by strobing each CS low. The DRDY output from both ADCs can be used; however, when the devices are synchronized, the DRDY output from only one device is sufficient.

(1) For DVDD < 2.25 V, tie DVDD and BYPASS together. see the DVDD Power Supply section.

Figure 82. Controller Interface with Dual ADCs
The modulator overrange flag (MFLAG) from each device ties to the controller input. For synchronization, connect all ADCs to the same SYNC signal. For reset, either connect all ADCs to the same RESET signal or connect the ADCs to individual RESET signals.
Avoid ringing on the digital inputs to the ADCs. Place $47-\Omega$ resistors in series with the digital traces to help reduce ringing by controlling impedances. Place the resistors at the source (driver) end of the trace. Do not float unused digital inputs; tie them to DVDD or GND.

### 9.3 Initialization Set Up

After reset or power-on, configure the registers using the following procedure:

1. Reset the serial interface. Before using the serial interface, it may be necessary to recover the serial interface (undefined I/O power-up sequencing may cause a false SCLK to occur). To reset the interface, toggle the $\overline{C S}$ pin high then low, or toggle the RESET pin high then low, or when in read-data-continuous mode, hold SCLK low for 64 DRDY periods.
2. Configure the registers. The registers are configured by either writing to them individually or as a group, and can be configured in either mode. To cancel read-data-continuous mode, send the SDATAC command before register read and write operations .
3. Verify register data. For verification of device communications, read back the register.
4. Set the data mode. After register configuration, configure the device for read-data-continuous mode by executing the RDATAC command, or configure for read-data-by-command mode (set in step 2, by the SDATAC command).
5. Synchronize readings. Whenever SYNC is high, the ADS1284 freely runs the data conversions. To resynchronize the conversions in pulse-sync mode, take SYNC low and then high. In continuous-sync mode, apply the synchronizing clock to the SYNC pin with a clock period equal to multiples of the ADC conversion period.
6. Read data. If read-data-continuous mode is active, the data are read directly after $\overline{\overline{D R D Y}}$ falls by applying SCLK pulses. If the read-data-continuous mode is inactive, the data can only be read by executing the RDATA command. The RDATA command must be sent in this mode to read each conversion result.

## 10 Device and Documentation Support

### 10.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 10.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E ${ }^{\text {TM }}$ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.
Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 10.3 Trademarks

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### 10.4 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 10.5 Glossary

SLYZ022 - TI Glossary.
This glossary lists and explains terms, acronyms, and definitions.

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## MECHANICAL DATA

RHF (R-PVQFN-N24) PLASTIC QUAD FLATPACK NO-LEAD


$$
\begin{array}{|l|l|l|l|l|l|}
\hline \phi & 0,10 \circledast & \mathbb{M} & \mathrm{C} & \mathrm{~A} & \mathrm{~B} \\
\hline & 0,05 \mathbb{M} & \mathrm{C} & \\
\hline
\end{array}
$$

NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. QFN (Quad Flatpack No-Lead) Package configuration.
D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
F. Falls within JEDEC MO-220.

## THERMAL PAD MECHANICAL DATA



NOTE: All linear dimensions are in millimeters

## LAND PATTERN DATA




NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com [http://www.ti.com](http://www.ti.com).
E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
F. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for vias placed in thermal pad.

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1284IRHFR | ACTIVE | VQFN | RHF | 24 | 3000 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | $\begin{aligned} & \hline \text { ADS } \\ & 1284 \\ & \hline \end{aligned}$ | Samples |
| ADS1284IRHFT | ACTIVE | VQFN | RHF | 24 | 250 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | $\begin{aligned} & \text { ADS } \\ & 1284 \end{aligned}$ | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000$ ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter $(\mathrm{mm})$ | Reel <br> Width <br> W1 (mm) | $\begin{gathered} \mathrm{AO} \\ (\mathrm{~mm}) \end{gathered}$ | $\begin{gathered} \mathrm{BO} \\ (\mathrm{~mm}) \end{gathered}$ | $\begin{gathered} \text { K0 } \\ (\mathrm{mm}) \end{gathered}$ | $\begin{gathered} \text { P1 } \\ (\mathrm{mm}) \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ (\mathrm{~mm}) \end{gathered}$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1284IRHFR | VQFN | RHF | 24 | 3000 | 330.0 | 12.4 | 4.3 | 5.3 | 1.3 | 8.0 | 12.0 | Q1 |
| ADS1284IRHFT | VQFN | RHF | 24 | 250 | 180.0 | 12.4 | 4.3 | 5.3 | 1.3 | 8.0 | 12.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1284IRHFR | VQFN | RHF | 24 | 3000 | 367.0 | 367.0 | 35.0 |
| ADS1284IRHFT | VQFN | RHF | 24 | 250 | 210.0 | 185.0 | 35.0 |



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.


SOLDER MASK DETAILS

## NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271)
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

## EXAMPLE STENCIL DESIGN

RHF0024A


SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
EXPOSED PAD 25
75\% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE SCALE:20X

NOTES: (continued)
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## IMPORTANT NOTICE AND DISCLAIMER

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[^0]:    (1) CLK rising edge to SYNC rising edge timing must not occur within the specified time window.
    (2) Continuous-sync mode; a free-running clock applied to the SYNC input without causing resynchronization. See Figure 54

